

(12)

United States Design Patent

He et al.

(10)

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(45)

Date of Patent:

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(54) PAIR OF EARPHONES

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(**) Term: 15 Years

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(51) LOC (14) Cl. 14-01

(52) U.S. Cl. D14/223
USPC

(58) Field of Classification Search
USPC D14/223, 205, 206; D24/174, 217, 218; 128/864, 865, 866; 181/129, 130, 135;
(Continued)

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(Continued)

Primary Examiner — Katie Jane Stofko

(57) CLAIM

The ornamental design for a pair of earphones, as shown and described.

DESCRIPTION

FIG. 1 is a front elevation view of a first embodiment of a right earphone of a pair of earphones showing our new design;

FIG. 2 is a rear elevation view thereof;
FIG. 3 is a left side elevation view thereof;
FIG. 4 is a right side elevation view thereof;
FIG. 5 is a top plan view thereof;
FIG. 6 is a bottom plan view thereof;
FIG. 7 is a front, bottom and left side perspective view thereof;
FIG. 8 is a front elevation view of a first embodiment of a left earphone of the pair of earphones;
FIG. 9 is a rear elevation view thereof;
FIG. 10 is a left side elevation view thereof;
FIG. 11 is a right side elevation view thereof;
FIG. 12 is a top plan view thereof;
FIG. 13 is a bottom plan view thereof;
FIG. 14 is a front, bottom and left side perspective view thereof;
FIG. 15 is a front, bottom and left side perspective view of the pair of earphones;
FIG. 16 is another front, bottom and left side perspective view of the pair of earphones shown in an environment of use;
FIG. 17 is a front elevation view of a second embodiment of a right earphone of a pair of earphones showing our new design;
FIG. 18 is a rear elevation view thereof;
FIG. 19 is a left side elevation view thereof;
FIG. 20 is a right side elevation view thereof;
FIG. 21 is a top plan view thereof;
FIG. 22 is a bottom plan view thereof;
FIG. 23 is a front, bottom and left side perspective view thereof;
FIG. 24 is a front elevation view of a second embodiment of a left earphone of the pair of earphones;
FIG. 25 is a rear elevation view thereof;
FIG. 26 is a left side elevation view thereof;
FIG. 27 is a right side elevation view thereof;
FIG. 28 is a top plan view thereof;
FIG. 29 is a bottom plan view thereof;
FIG. 30 is a front, bottom and left side perspective view thereof;
FIG. 31 is a front, bottom and left side perspective view of the pair of earphones; and,

(Continued)

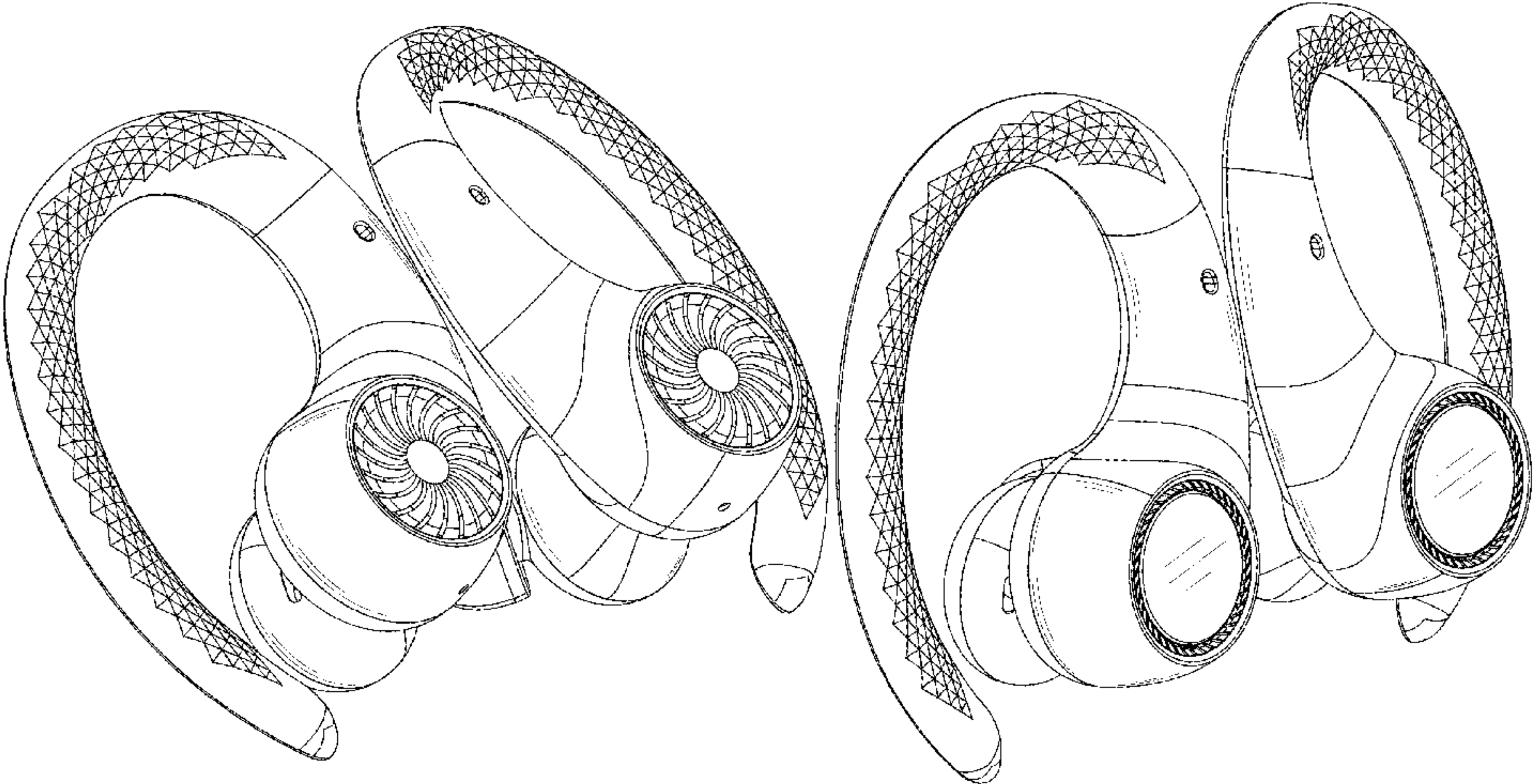


FIG. 32 is another front, bottom and left side perspective view of the pair of earphones shown in an environment of use.

The broken lines shown in FIGS. 16 and 32 illustrate the environment of the claimed design and form no part thereof.

1 Claim, 32 Drawing Sheets

(58) Field of Classification Search

USPC 379/430, 431; 381/380, 381, 322–324,
381/330; 455/90.3, 575, 1, 569.1;
D9/415, 432, 721; D3/274, 294;
D13/108
CPC H04R 1/10; H04R 25/00; H04R 1/1016;
H04R 1/1066; H04R 5/033; H04R
5/0335; H04R 1/1091; H04R 1/1058;
H04R 1/105; H04R 1/1083

See application file for complete search history.

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* cited by examiner

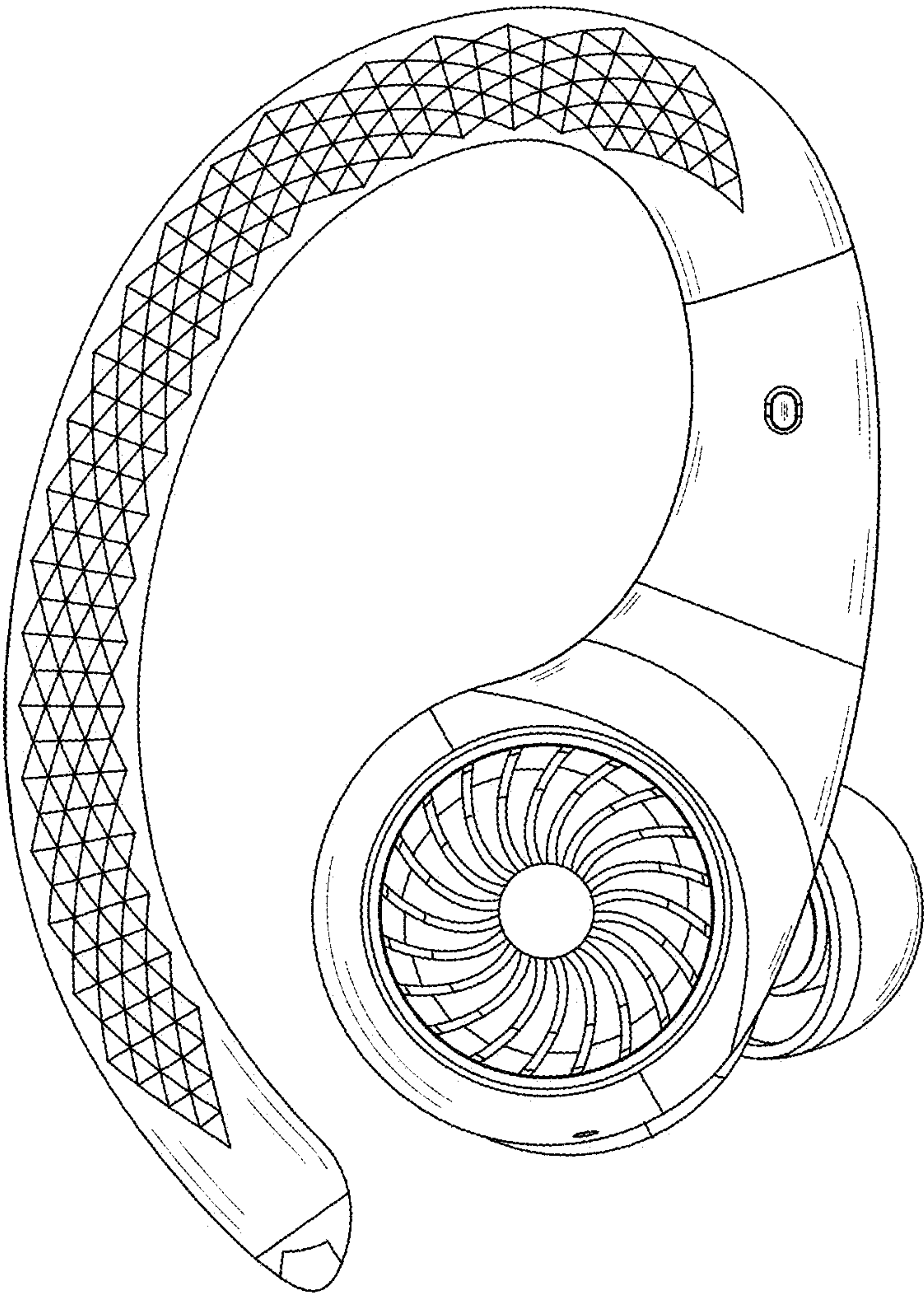


FIG.1

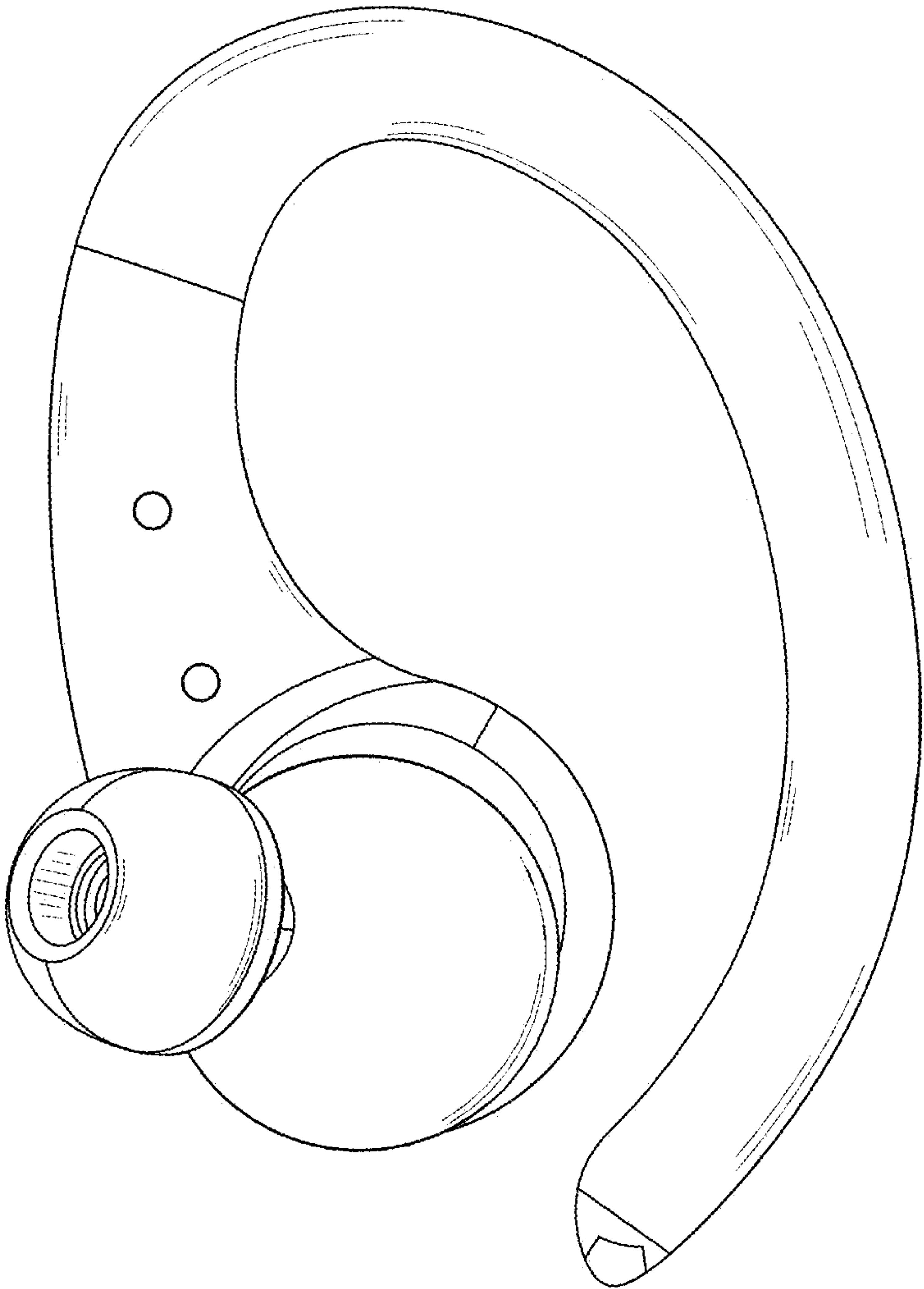


FIG.2

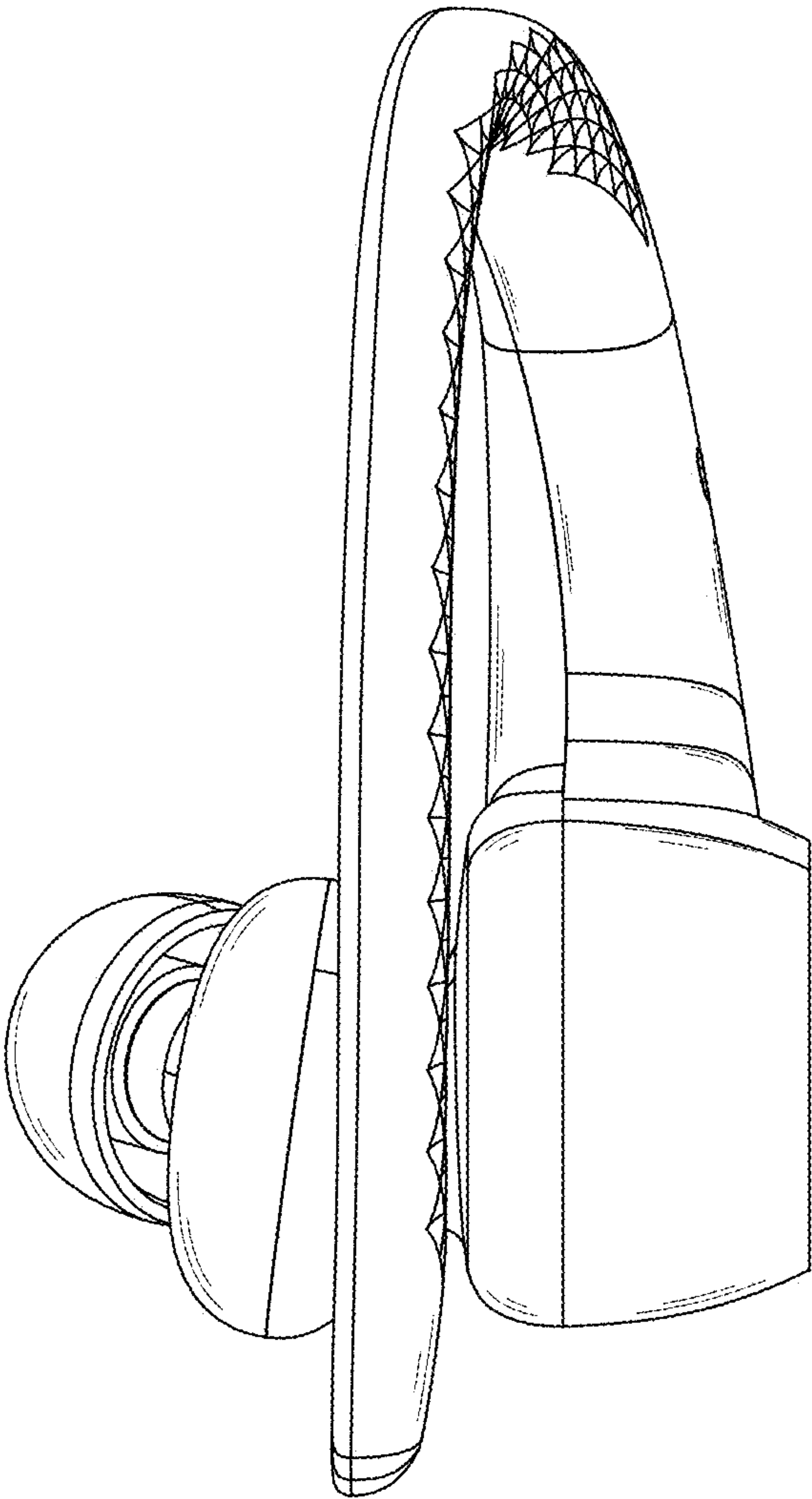


FIG.3

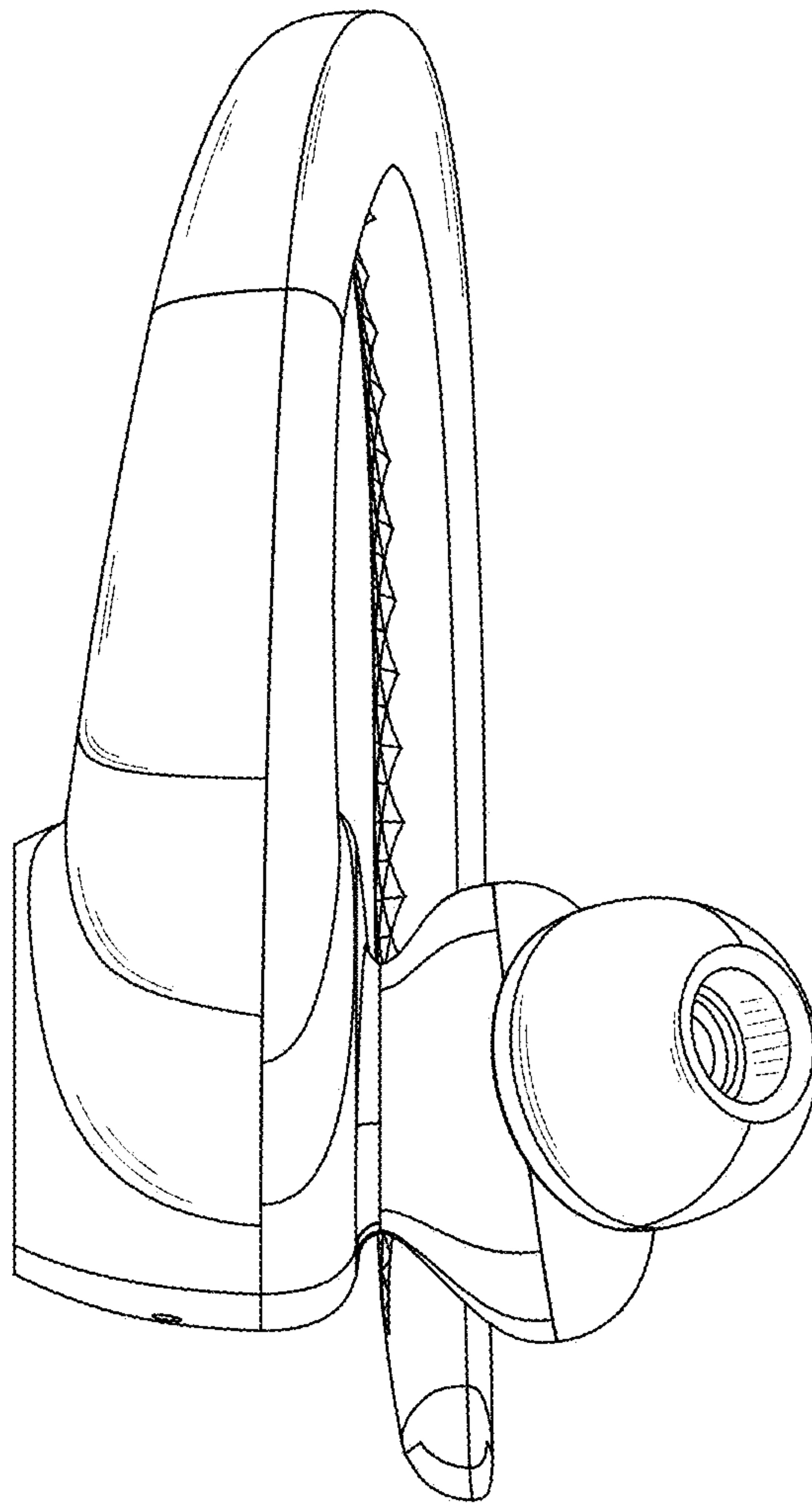


FIG.4

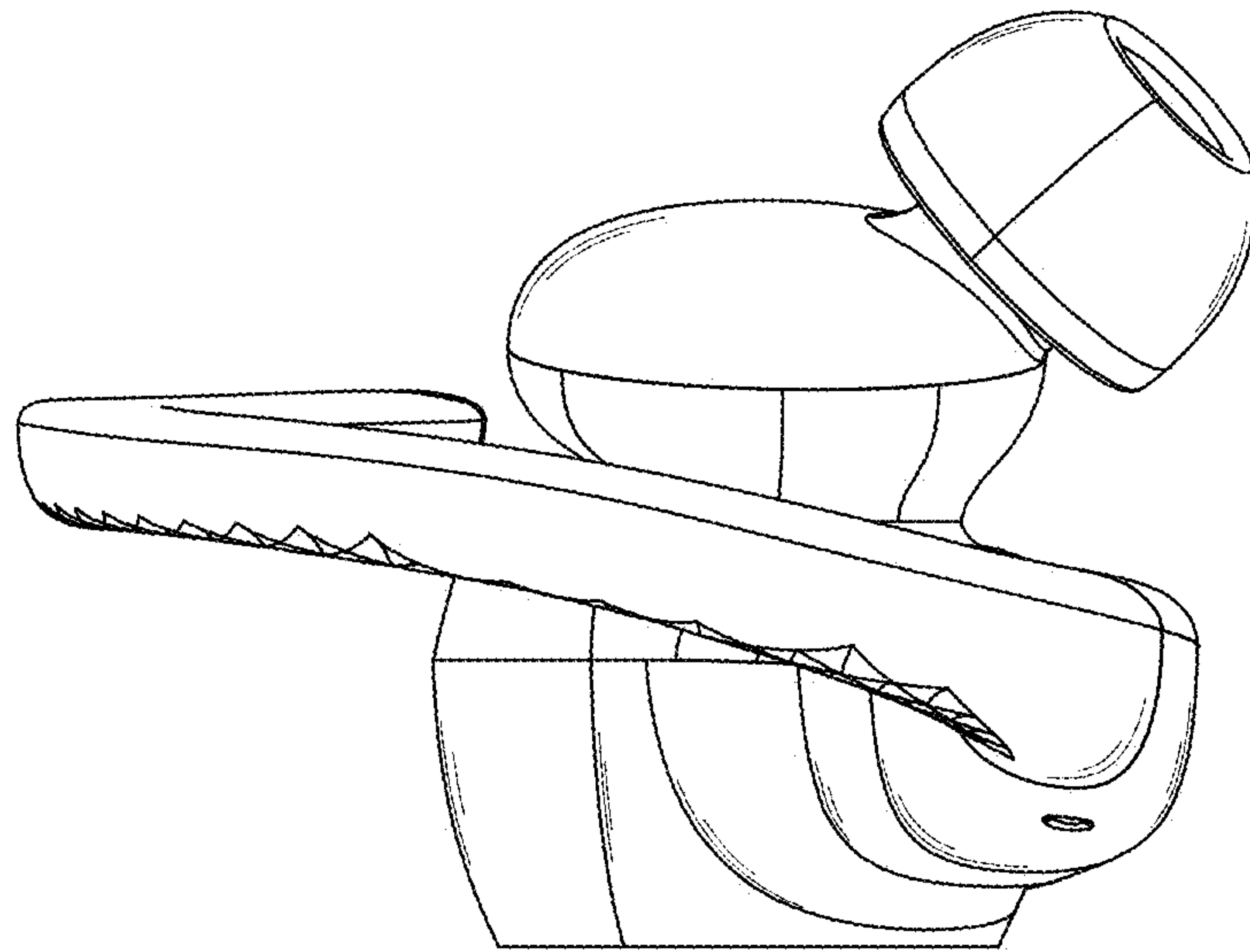


FIG.5

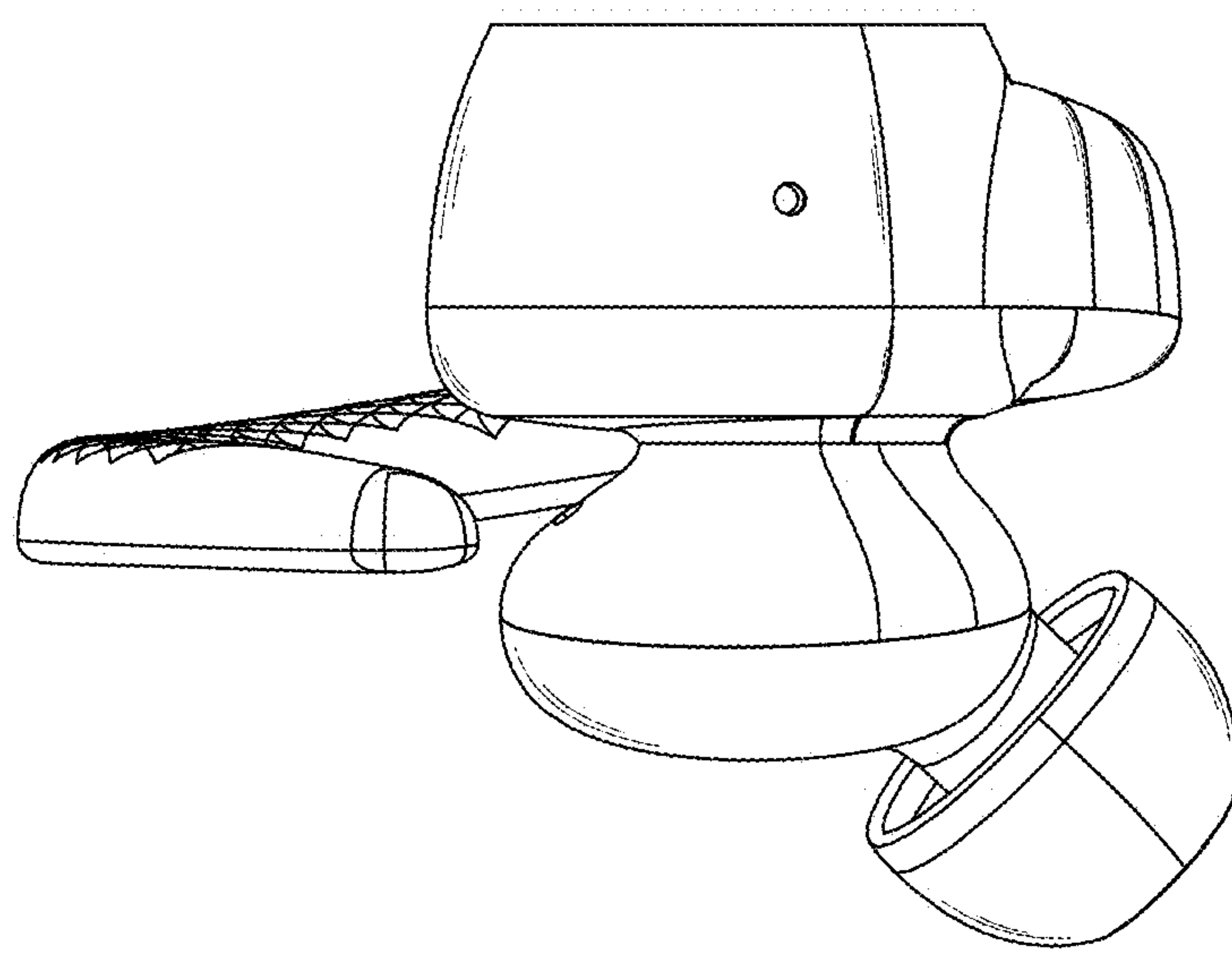


FIG.6

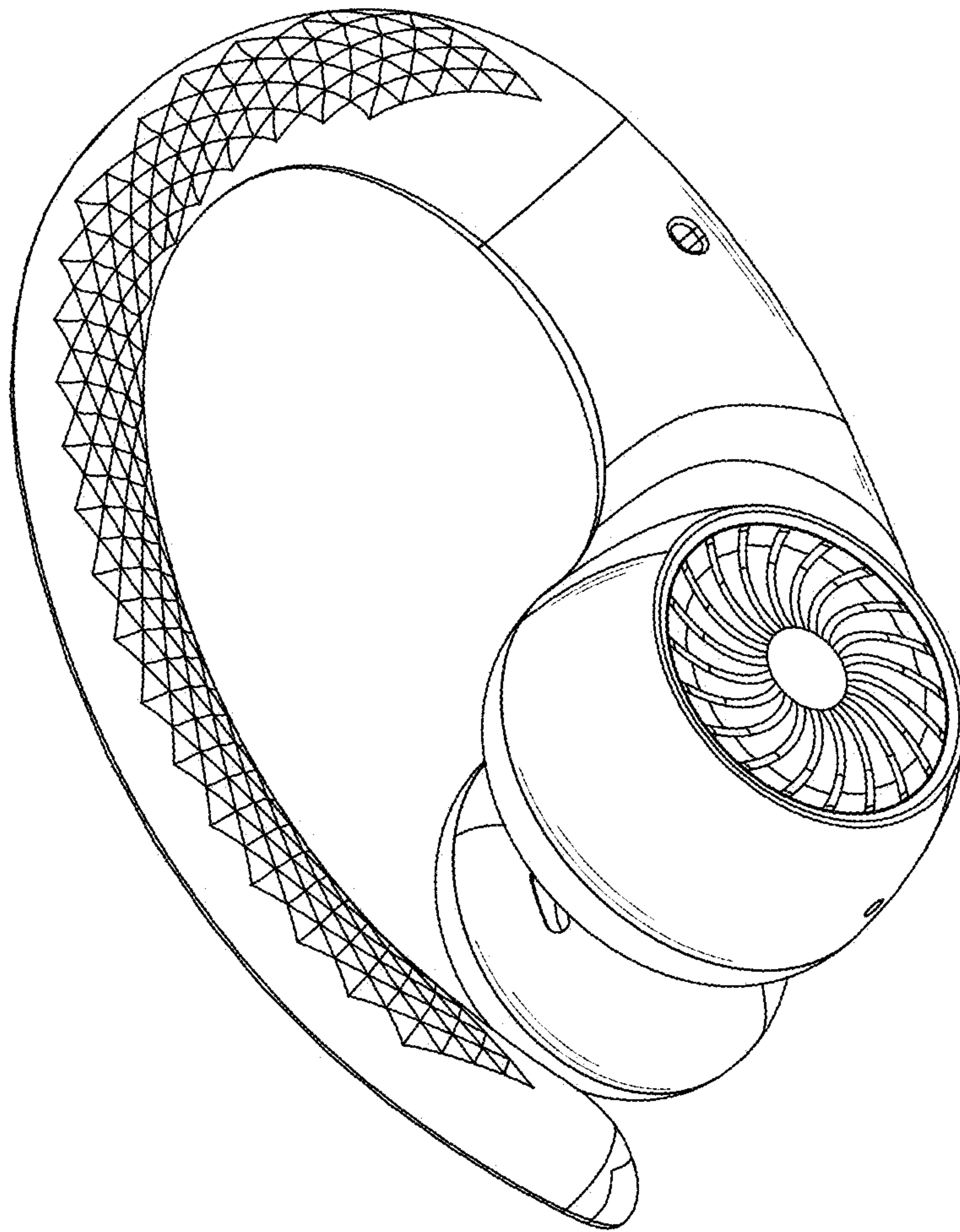


FIG.7

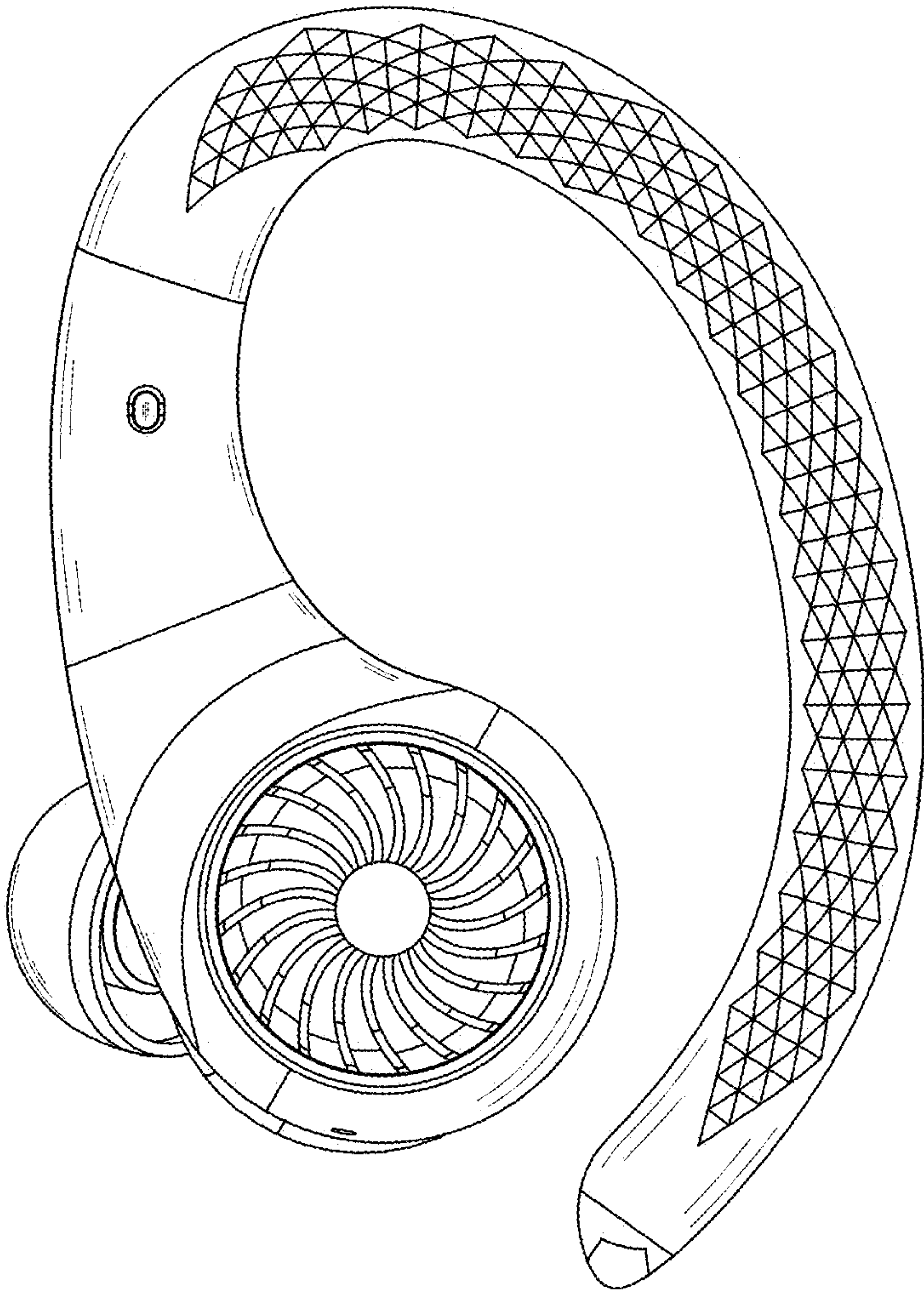


FIG.8

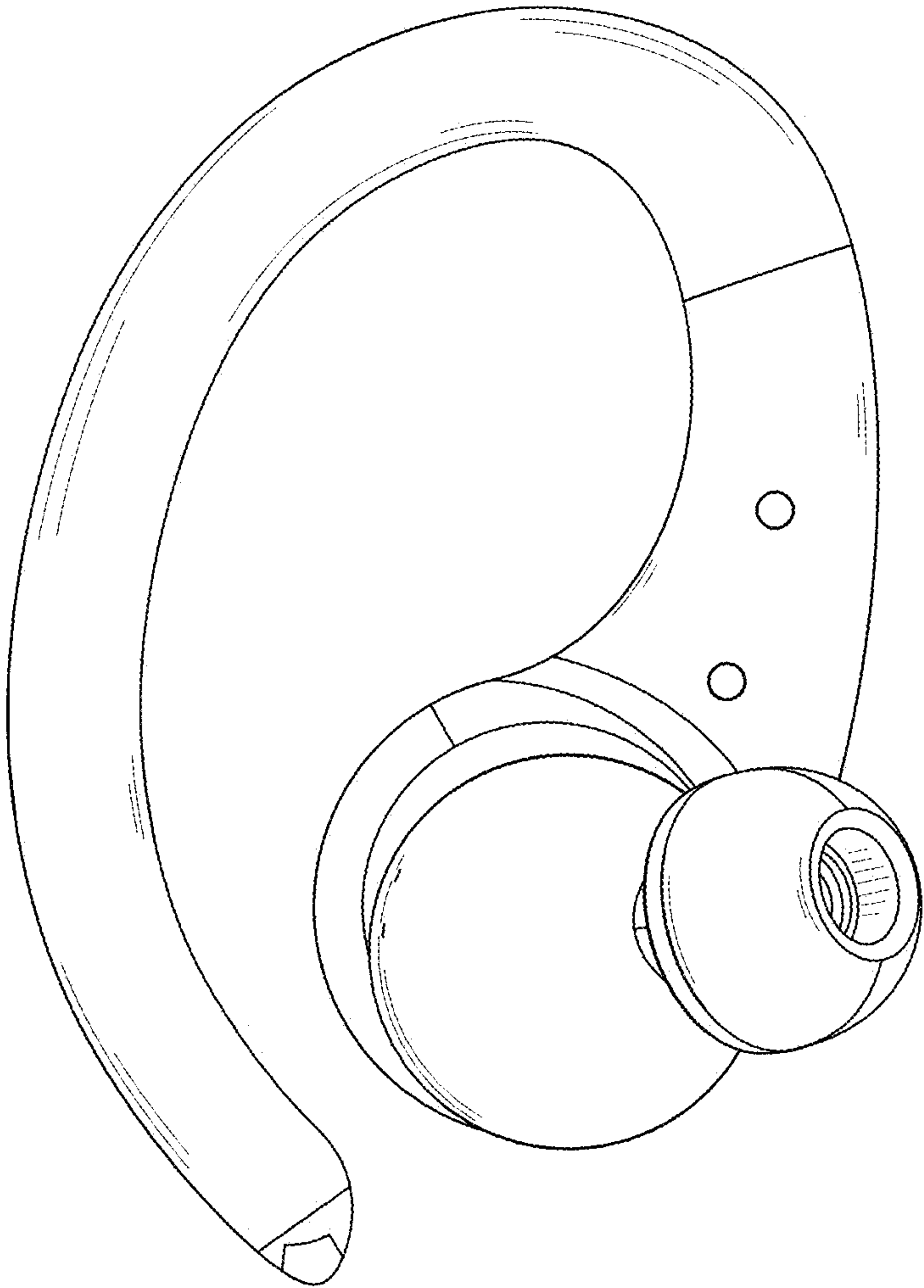


FIG.9

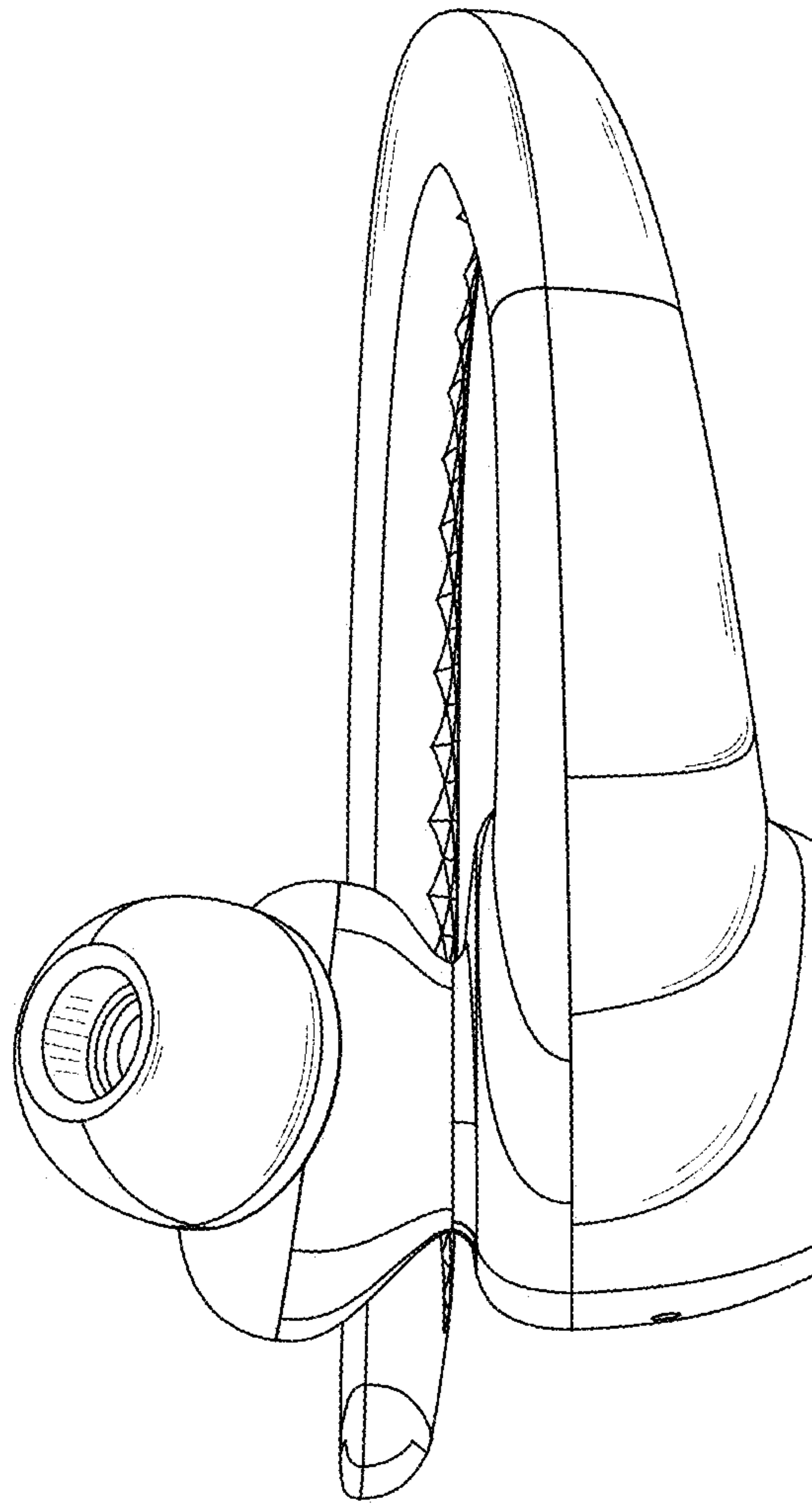


FIG.10

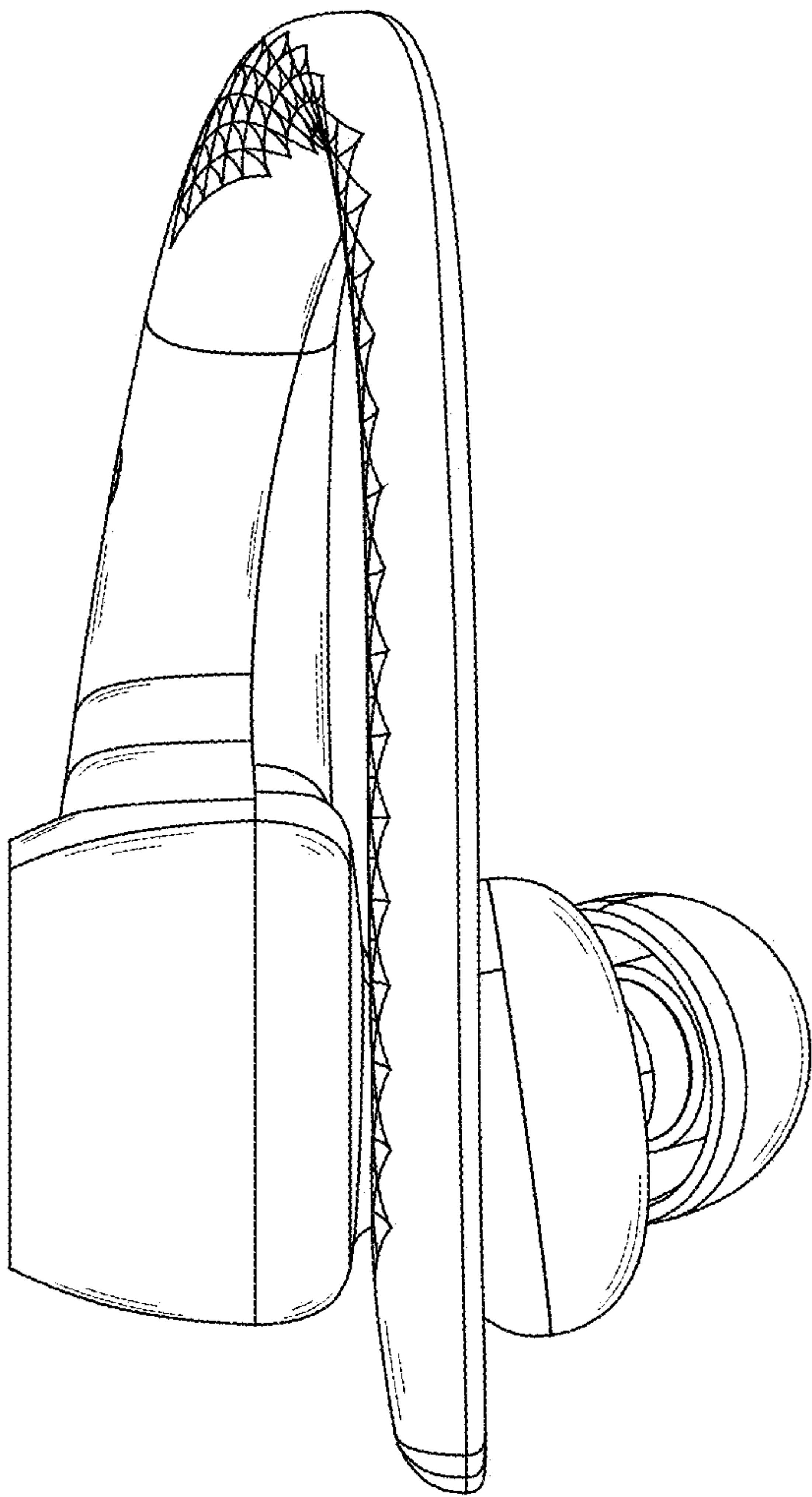


FIG.11

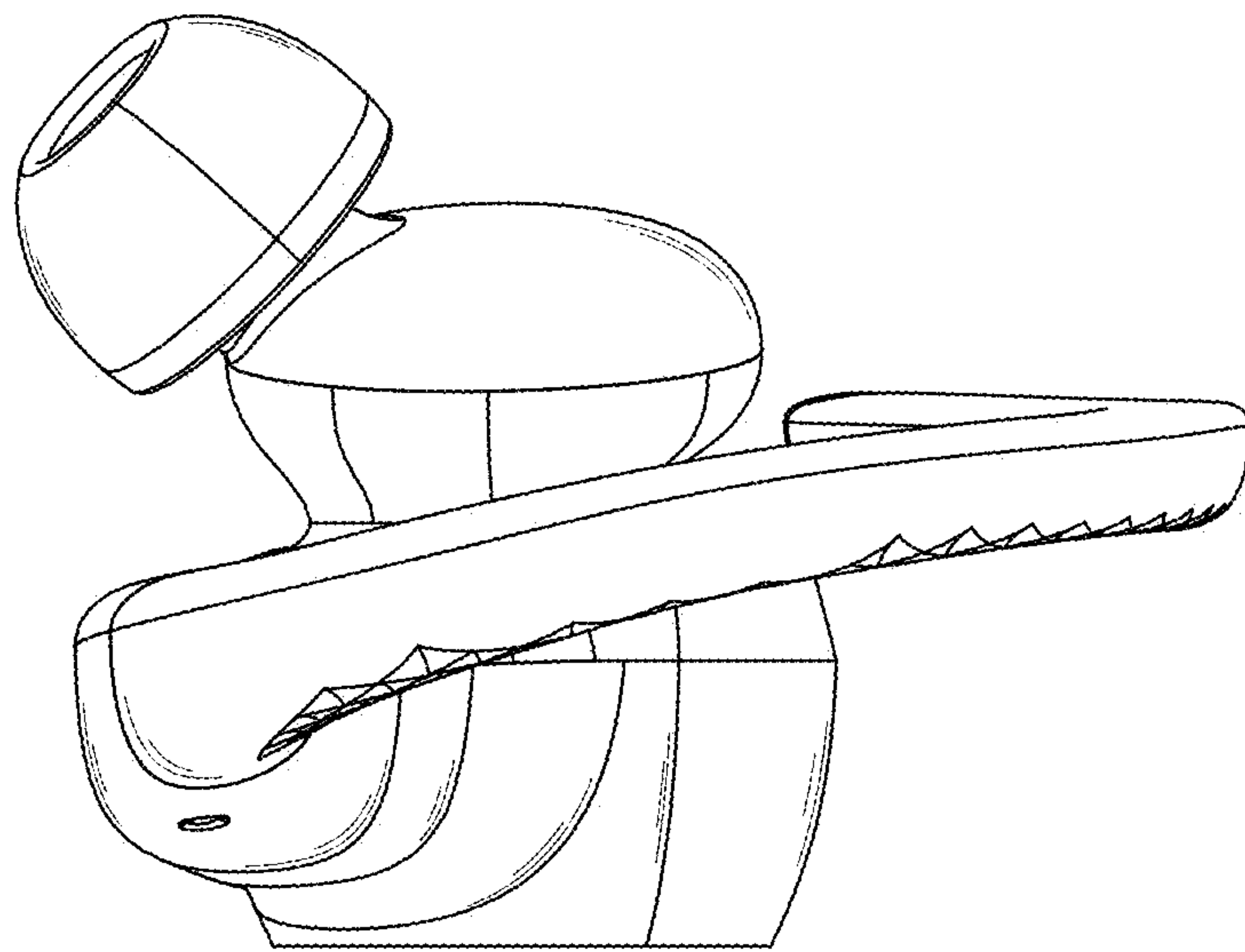


FIG.12

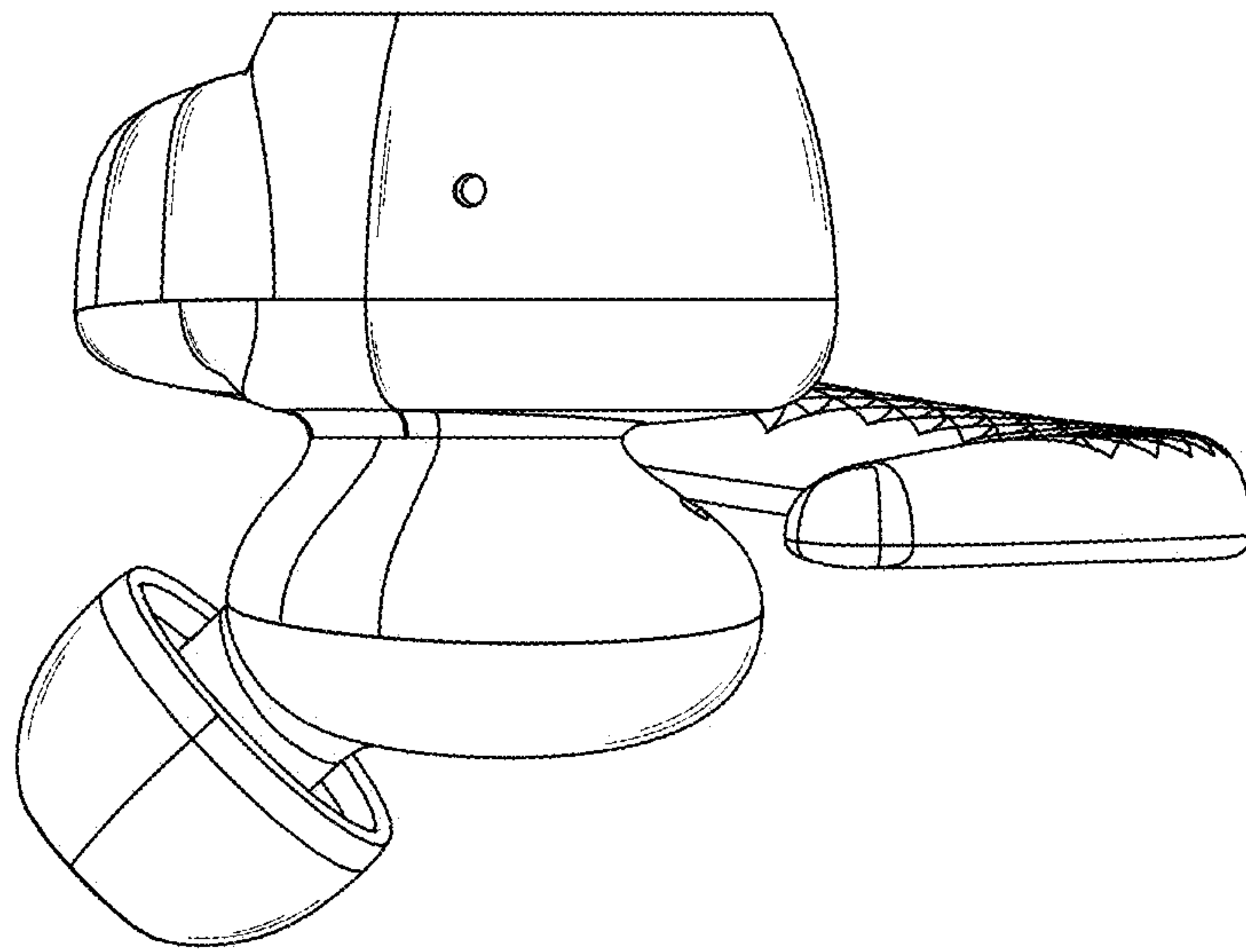


FIG.13

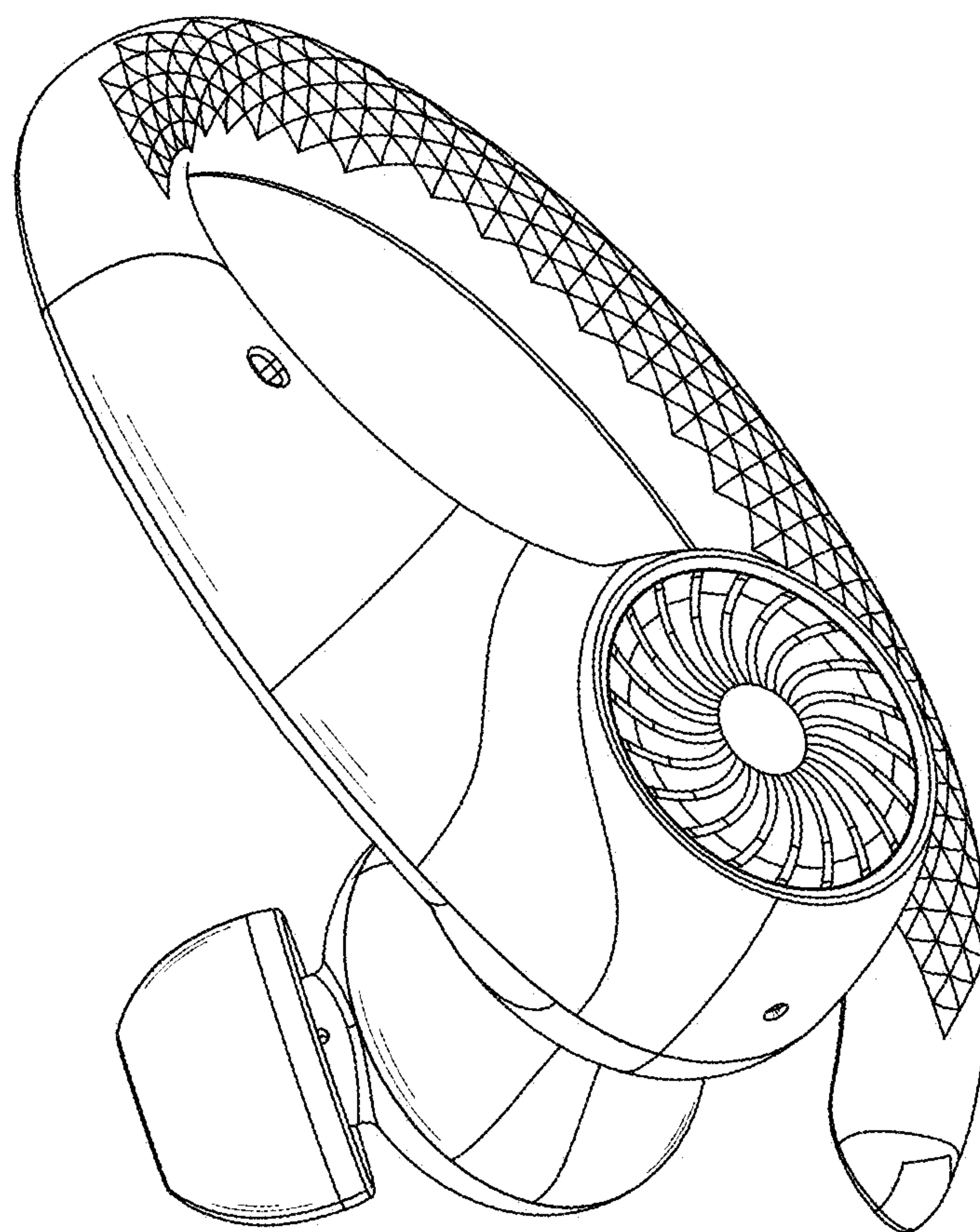


FIG.14

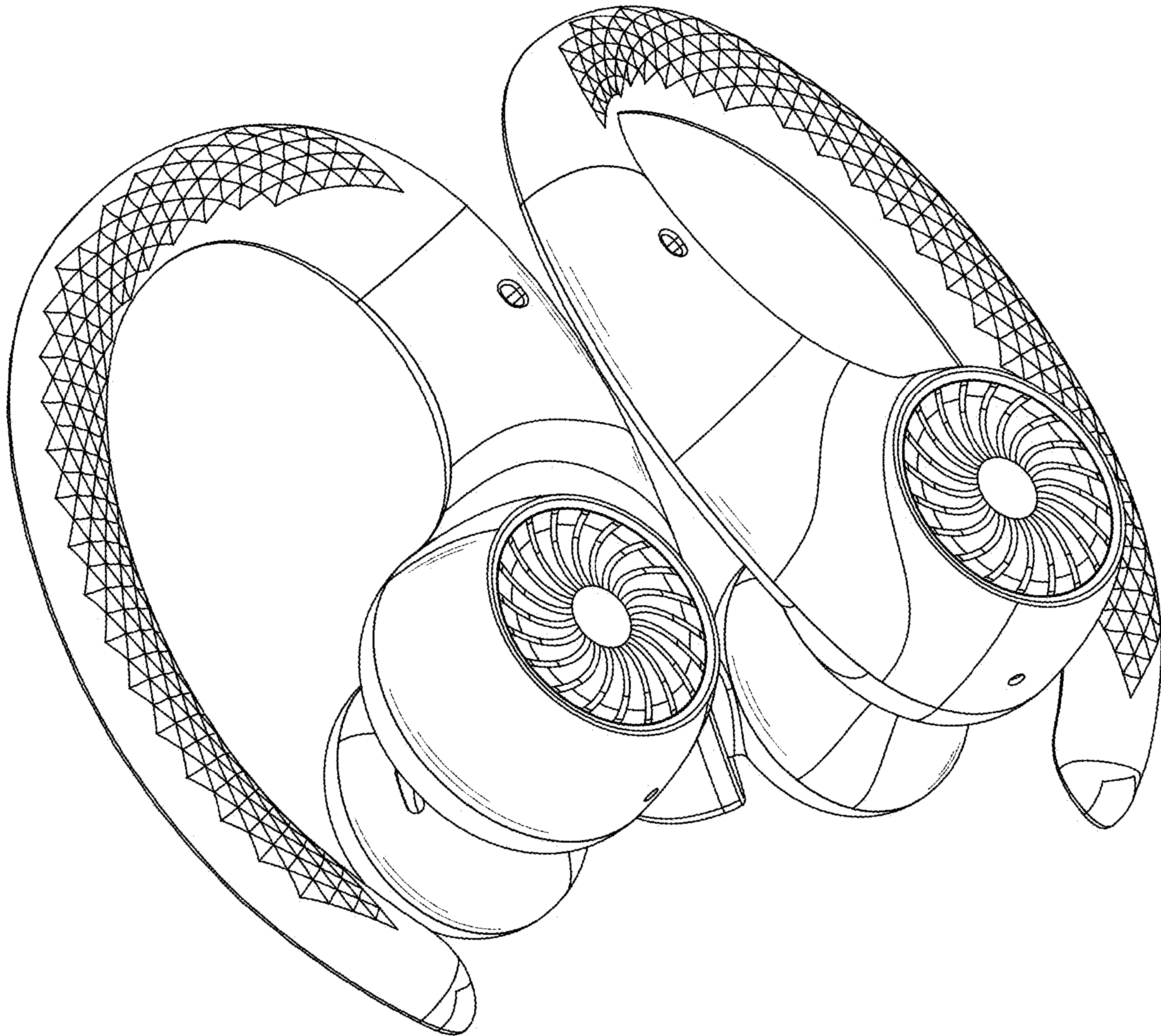


FIG.15

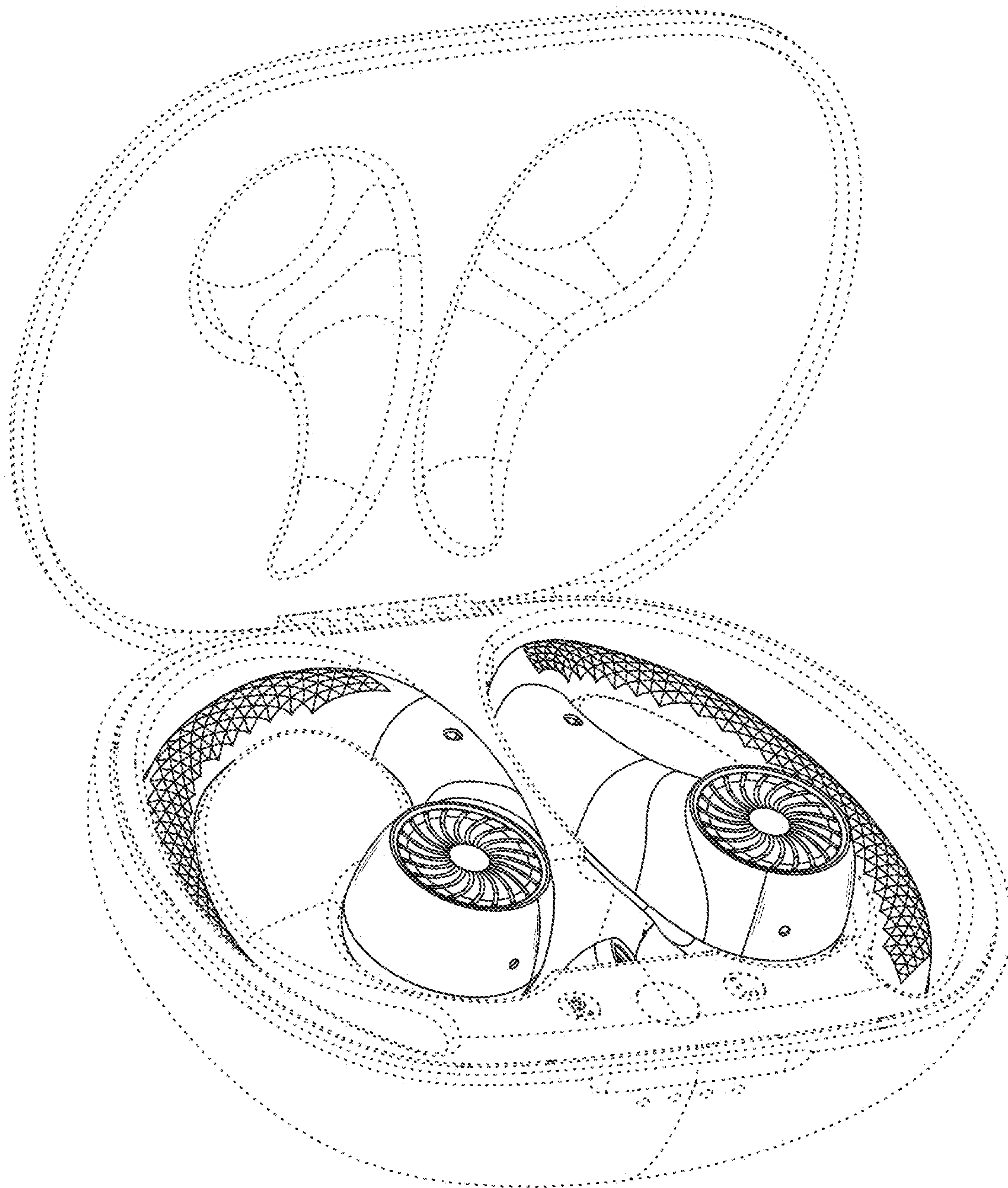


FIG. 16

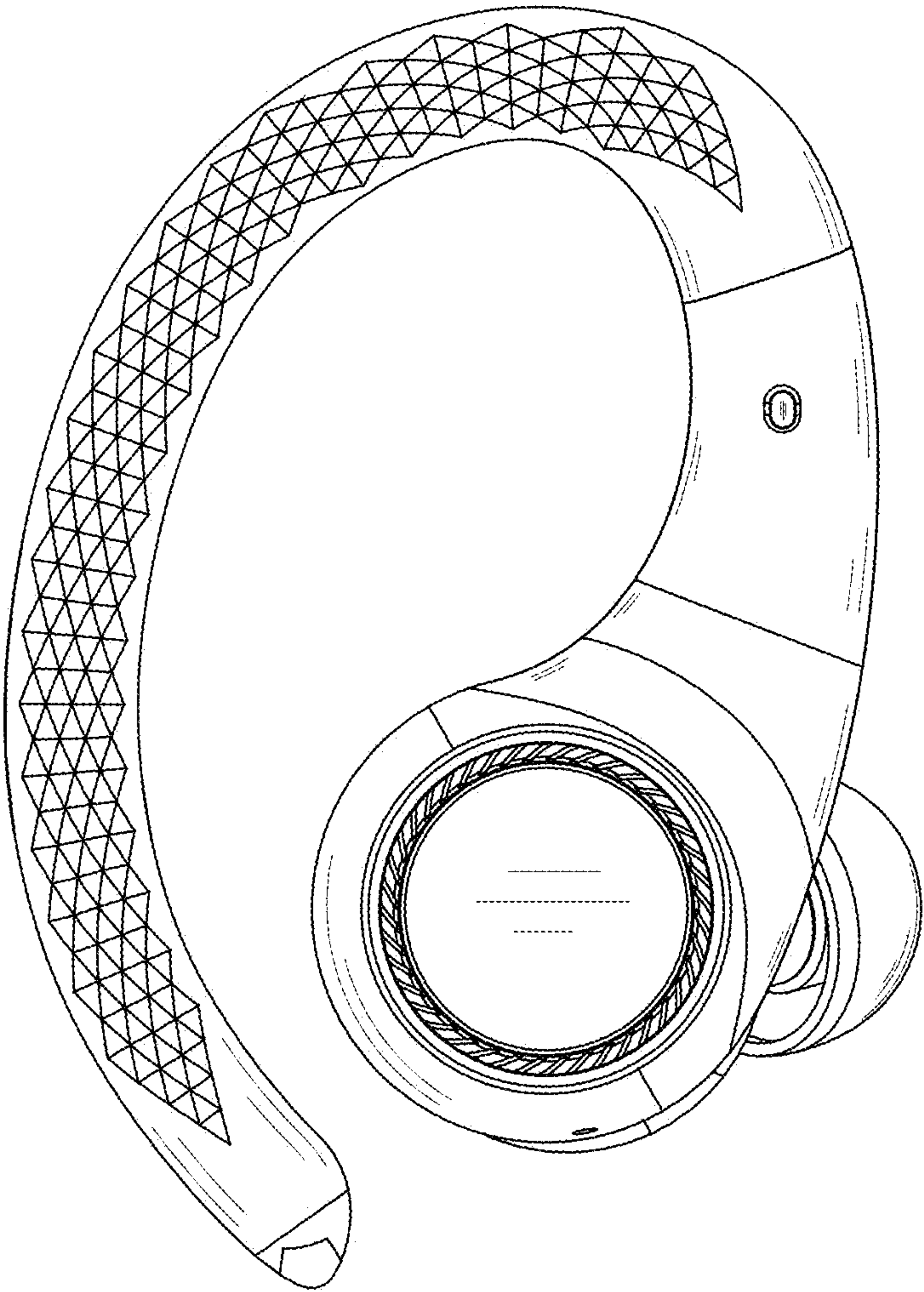


FIG.17

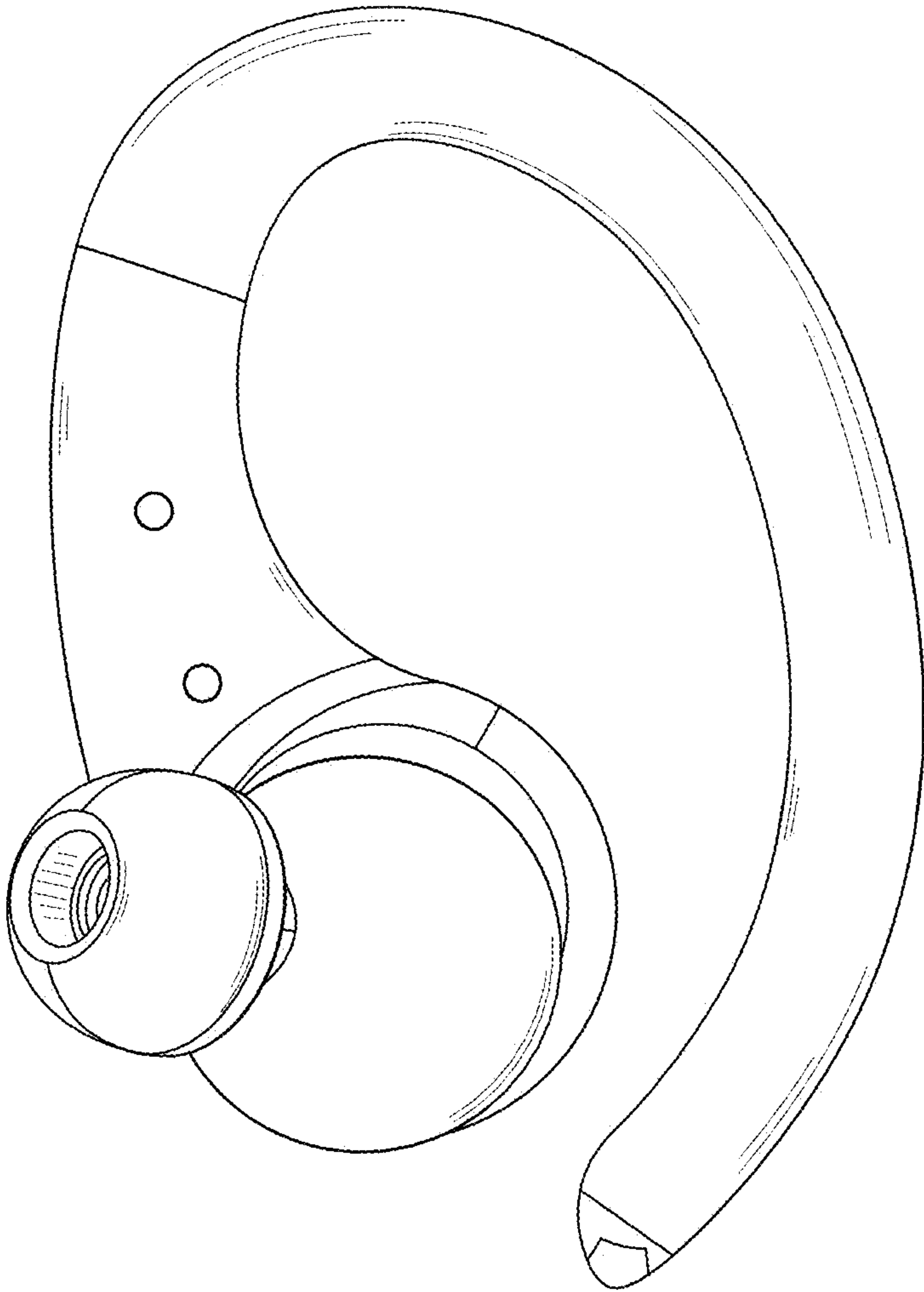


FIG.18

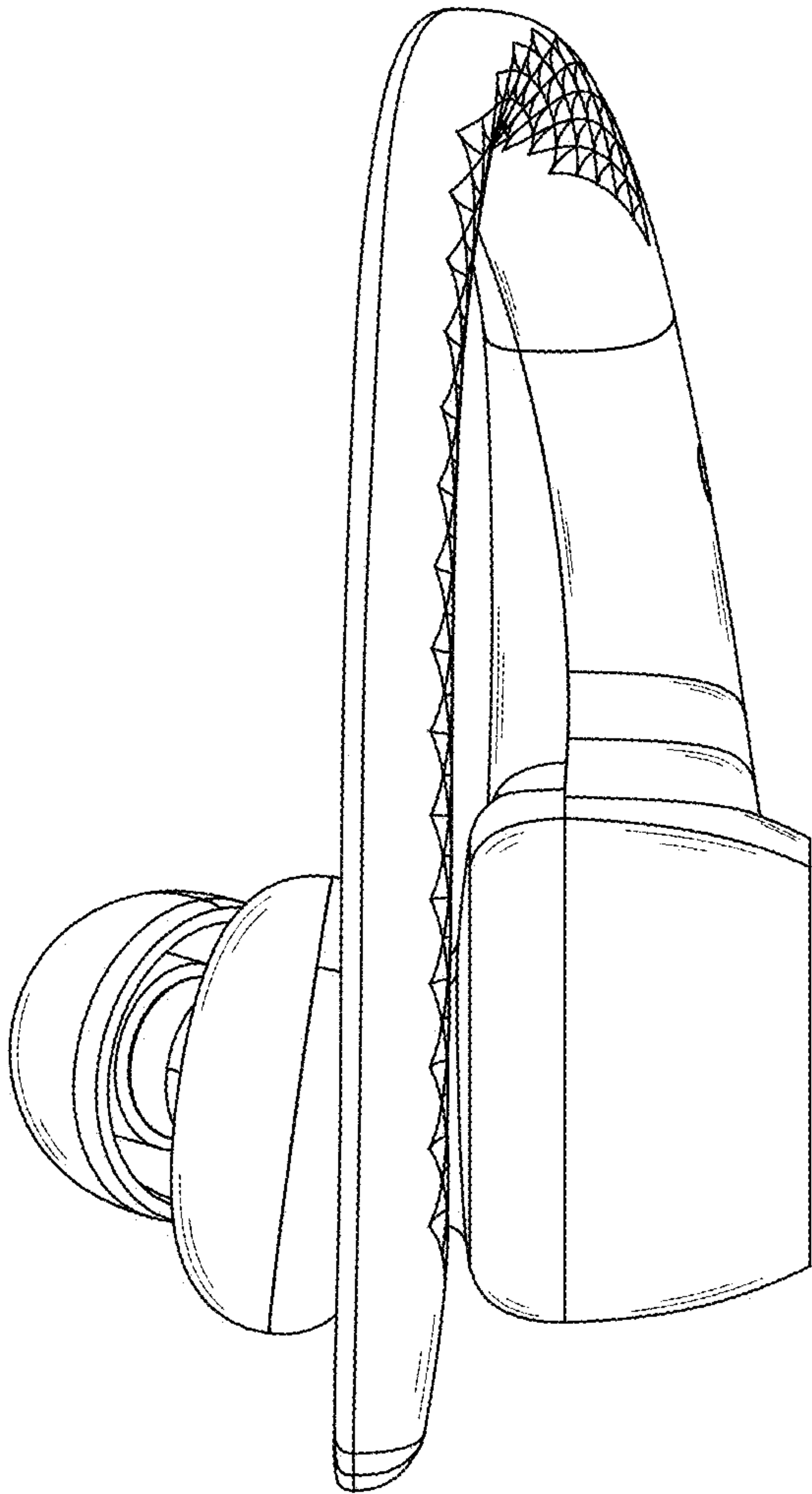


FIG.19

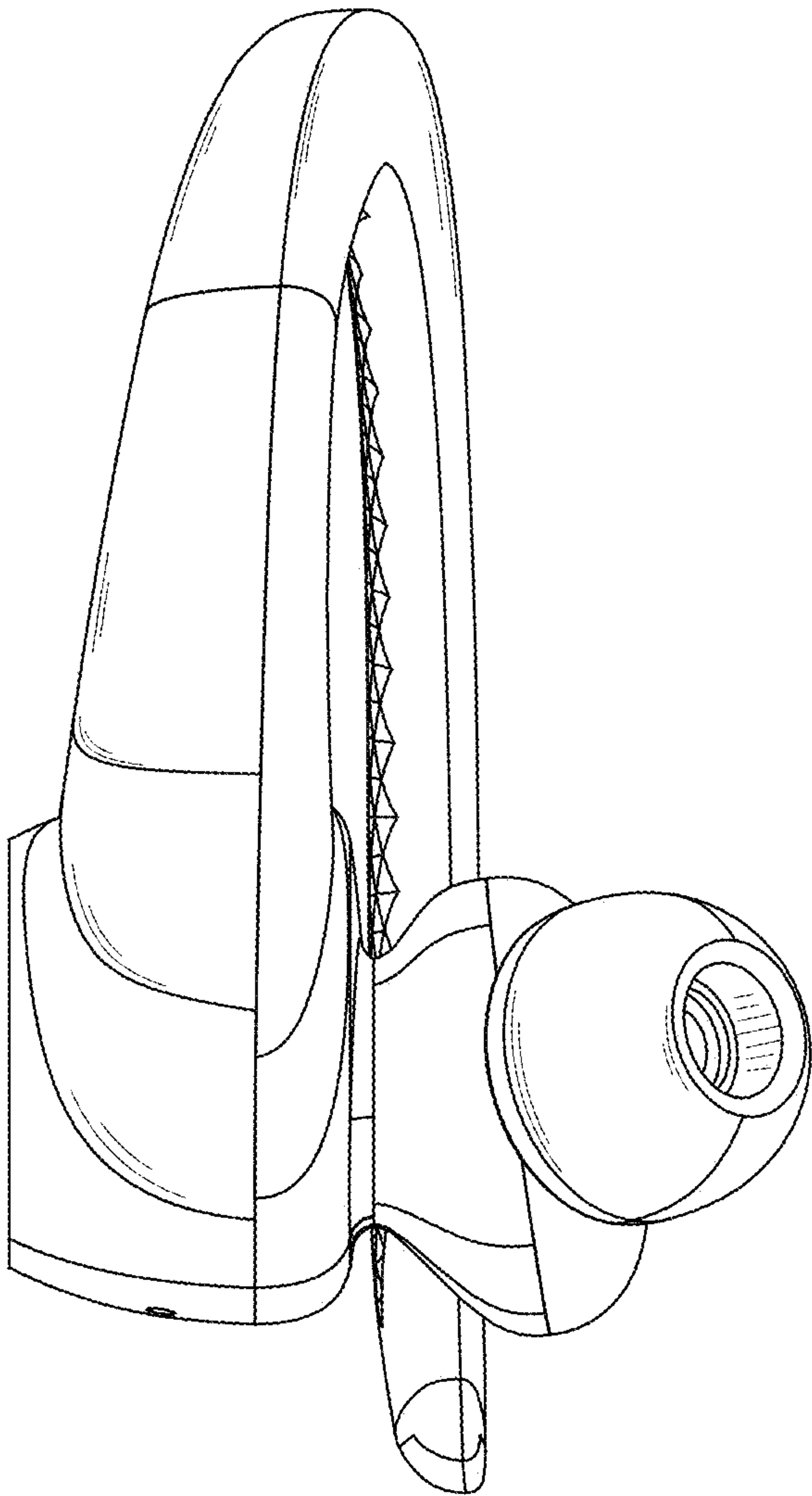


FIG.20

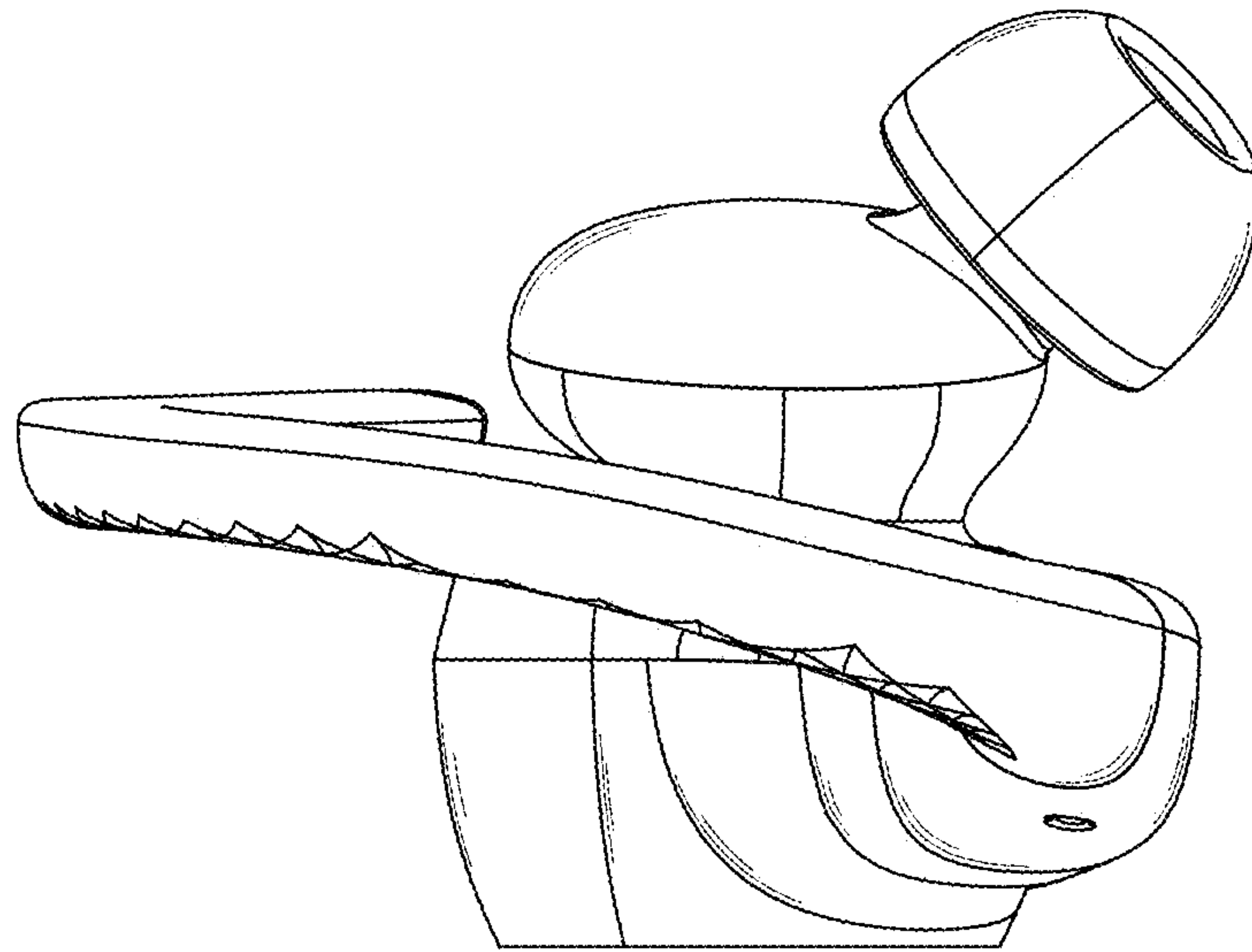


FIG.21

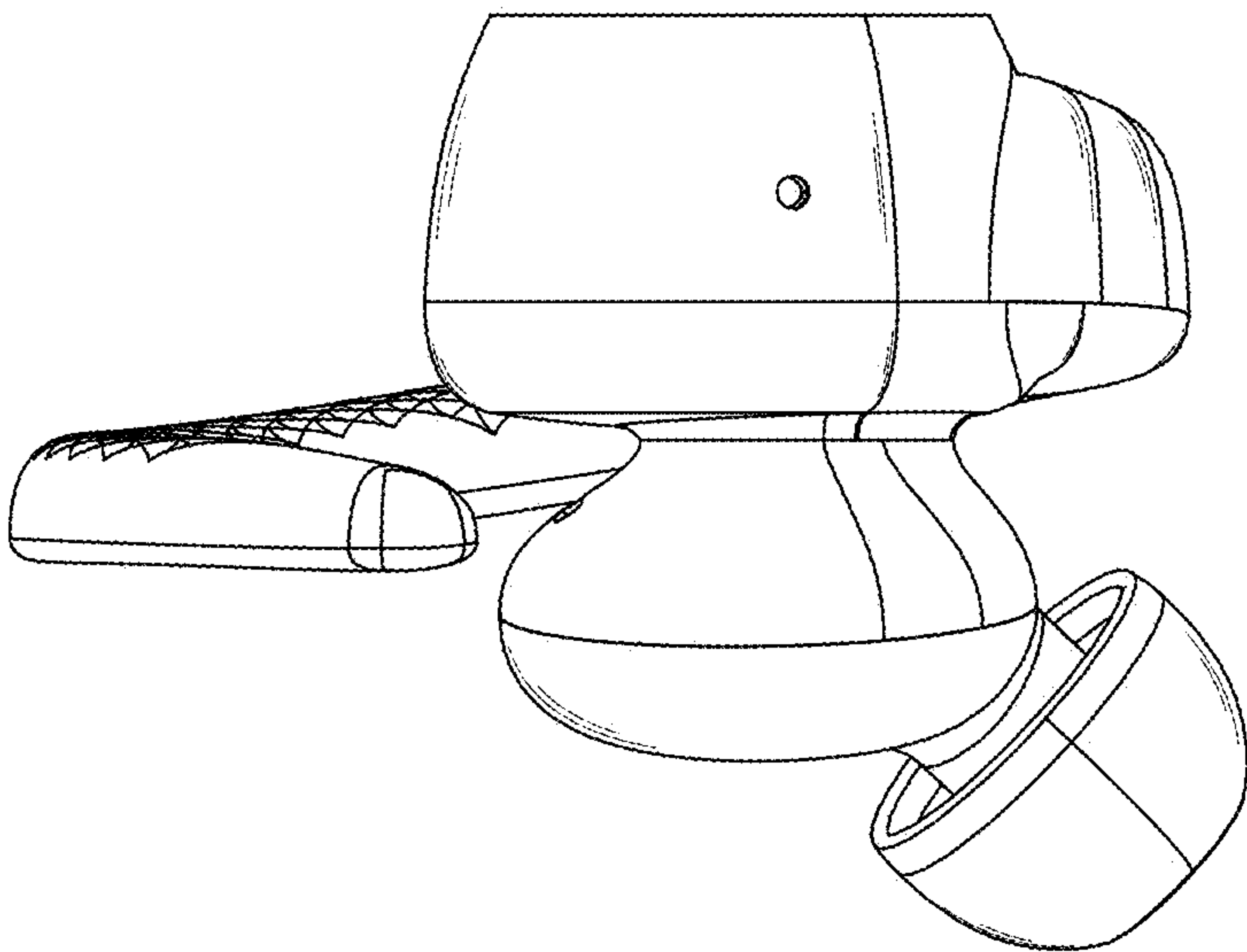


FIG.22

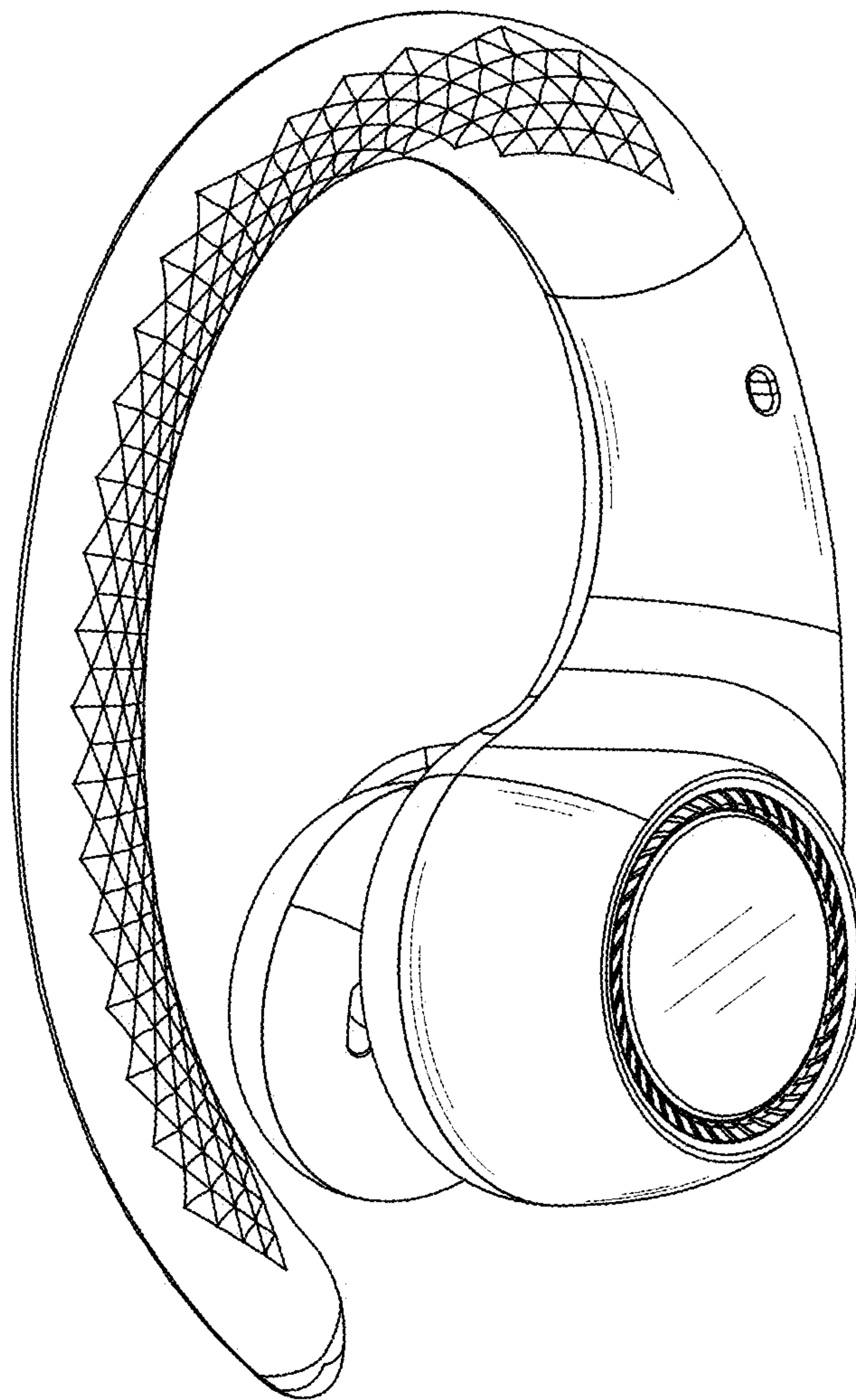


FIG.23

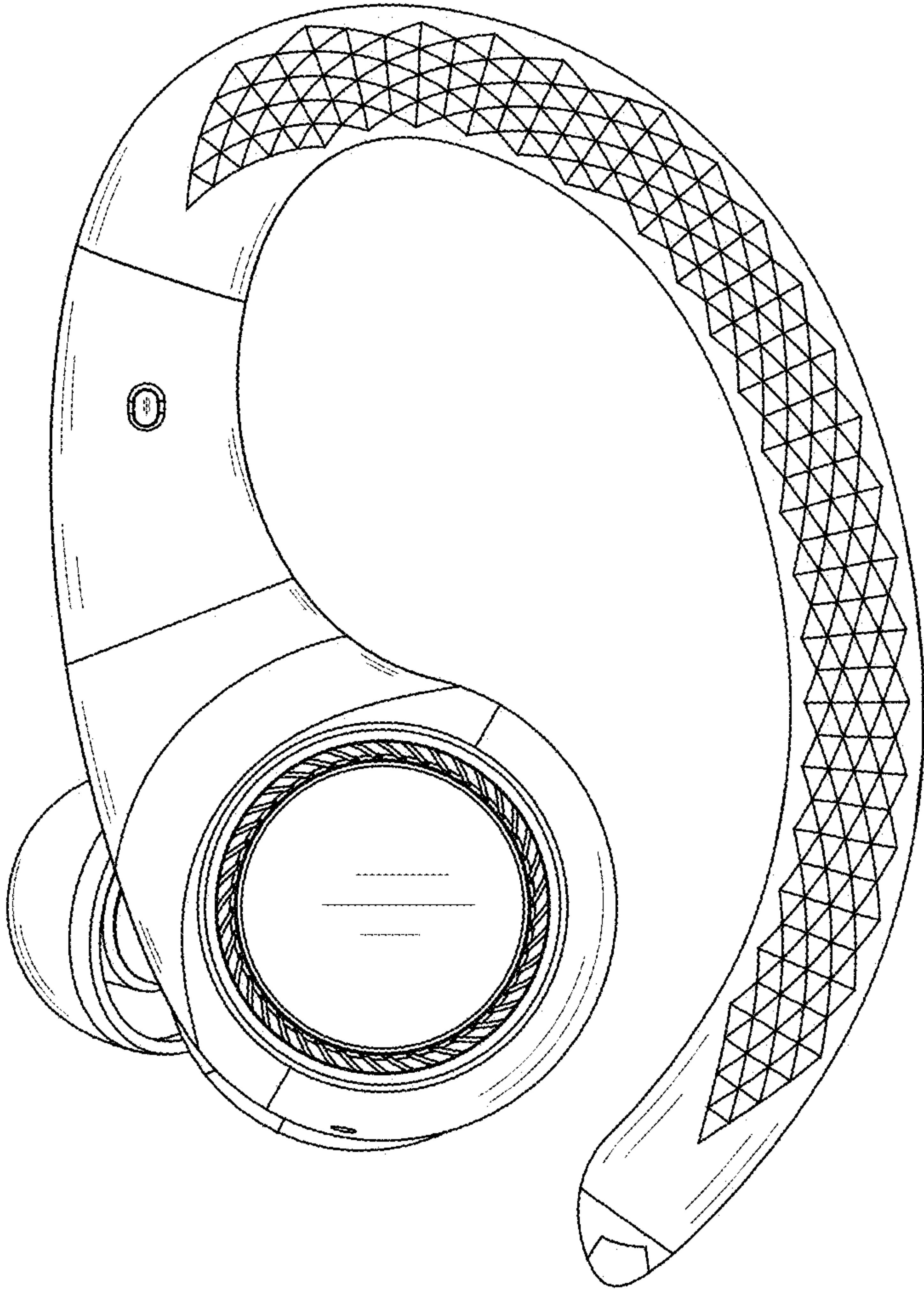


FIG.24

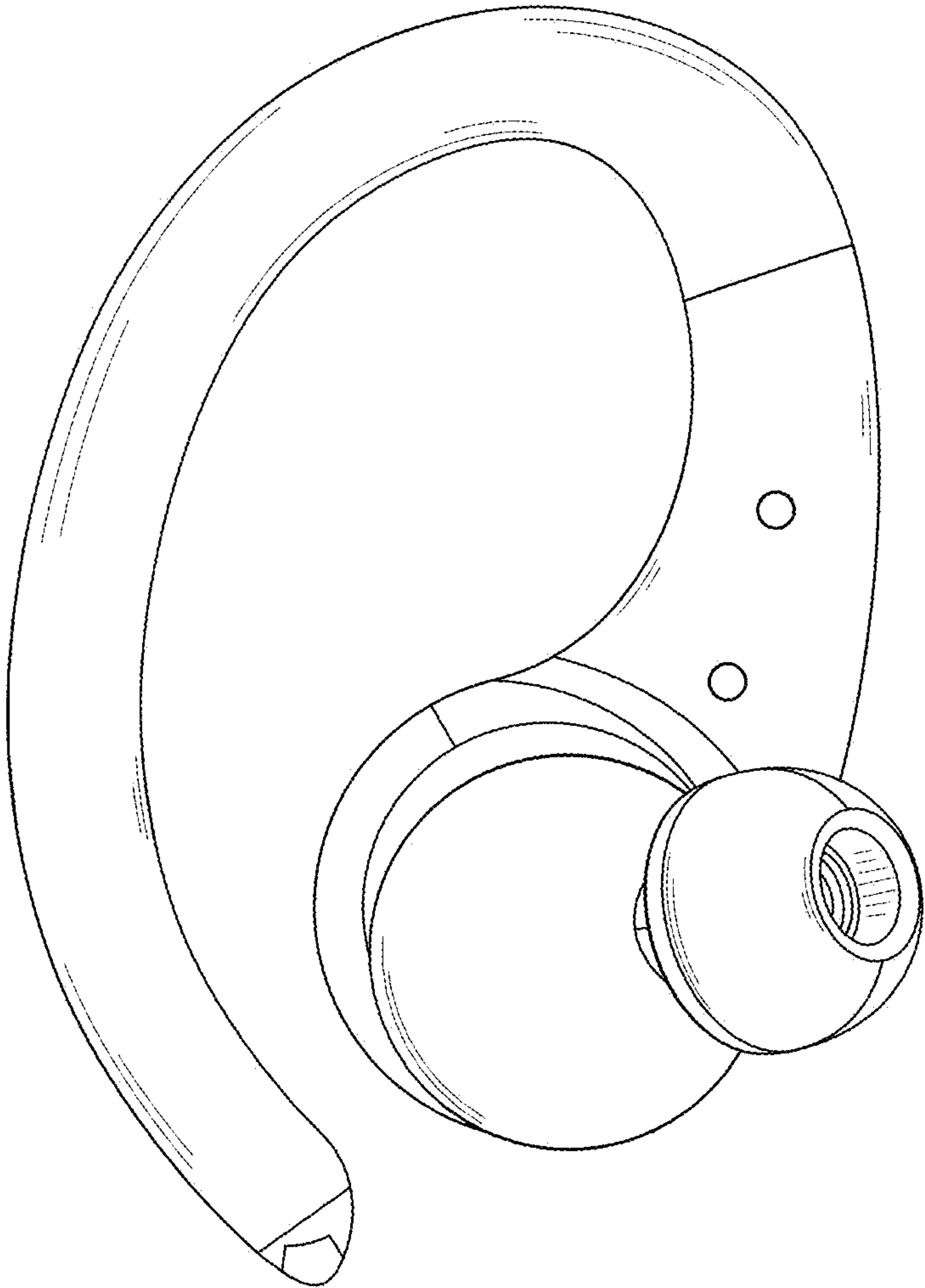


FIG.25

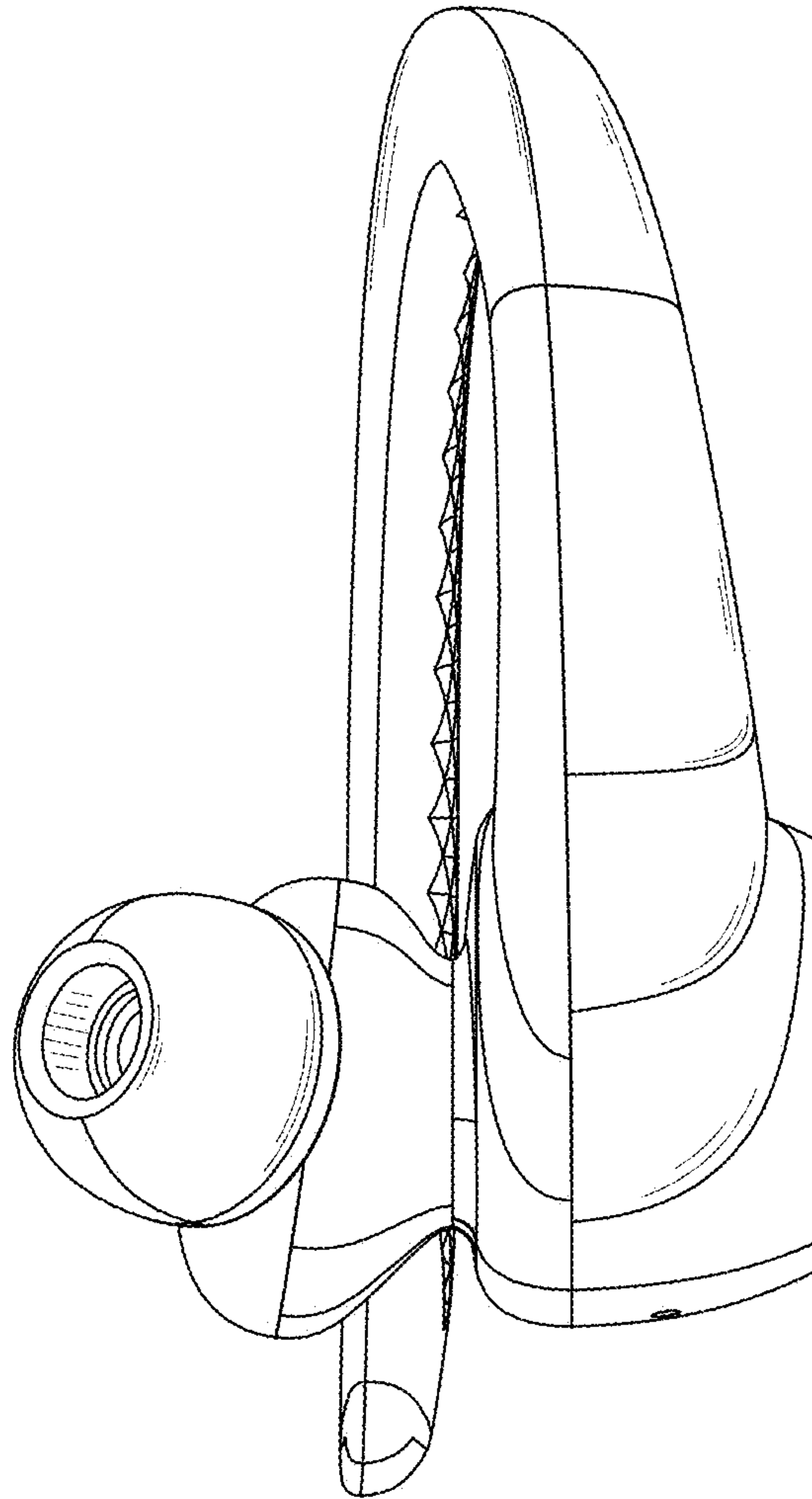


FIG.26

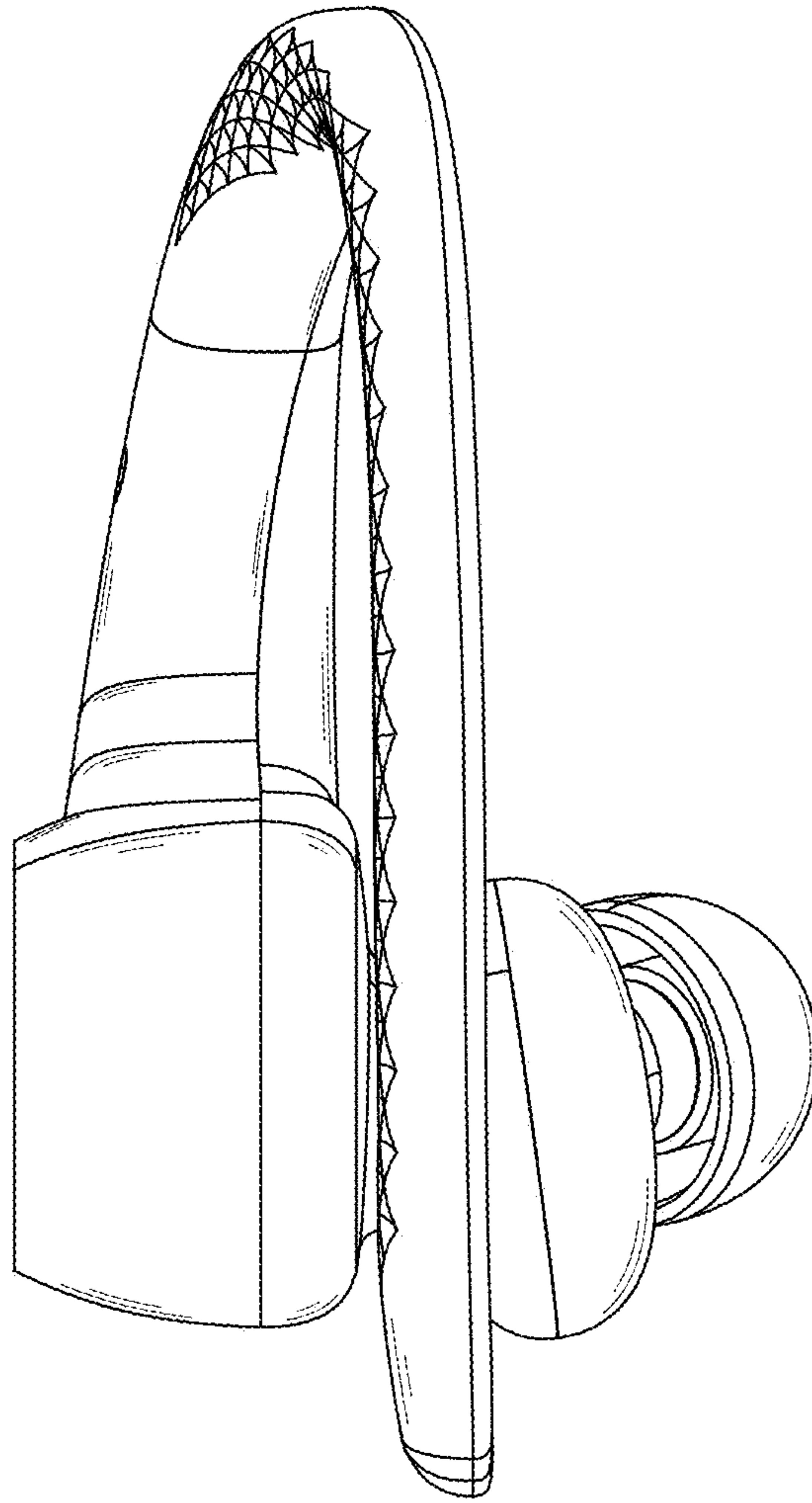


FIG.27

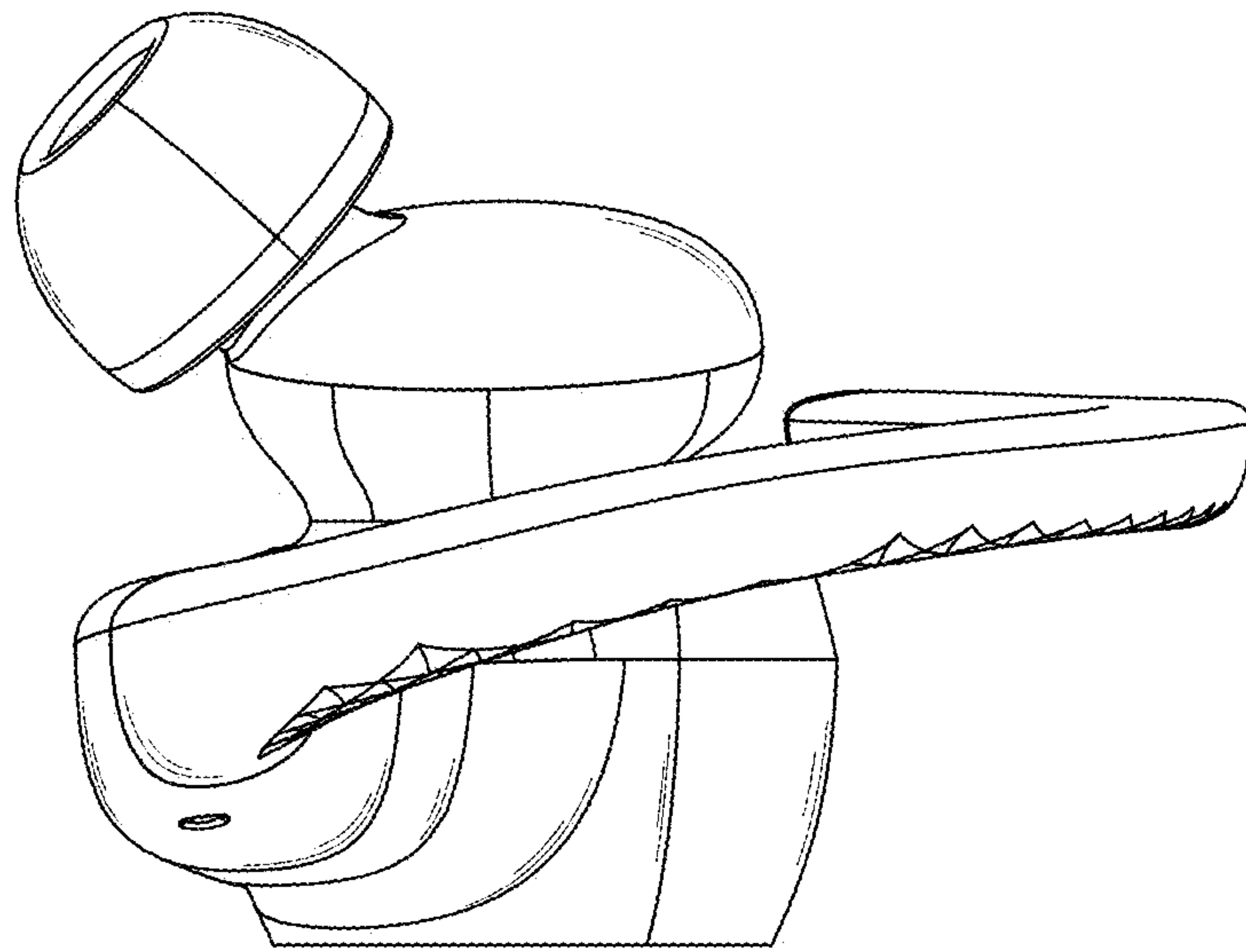


FIG.28

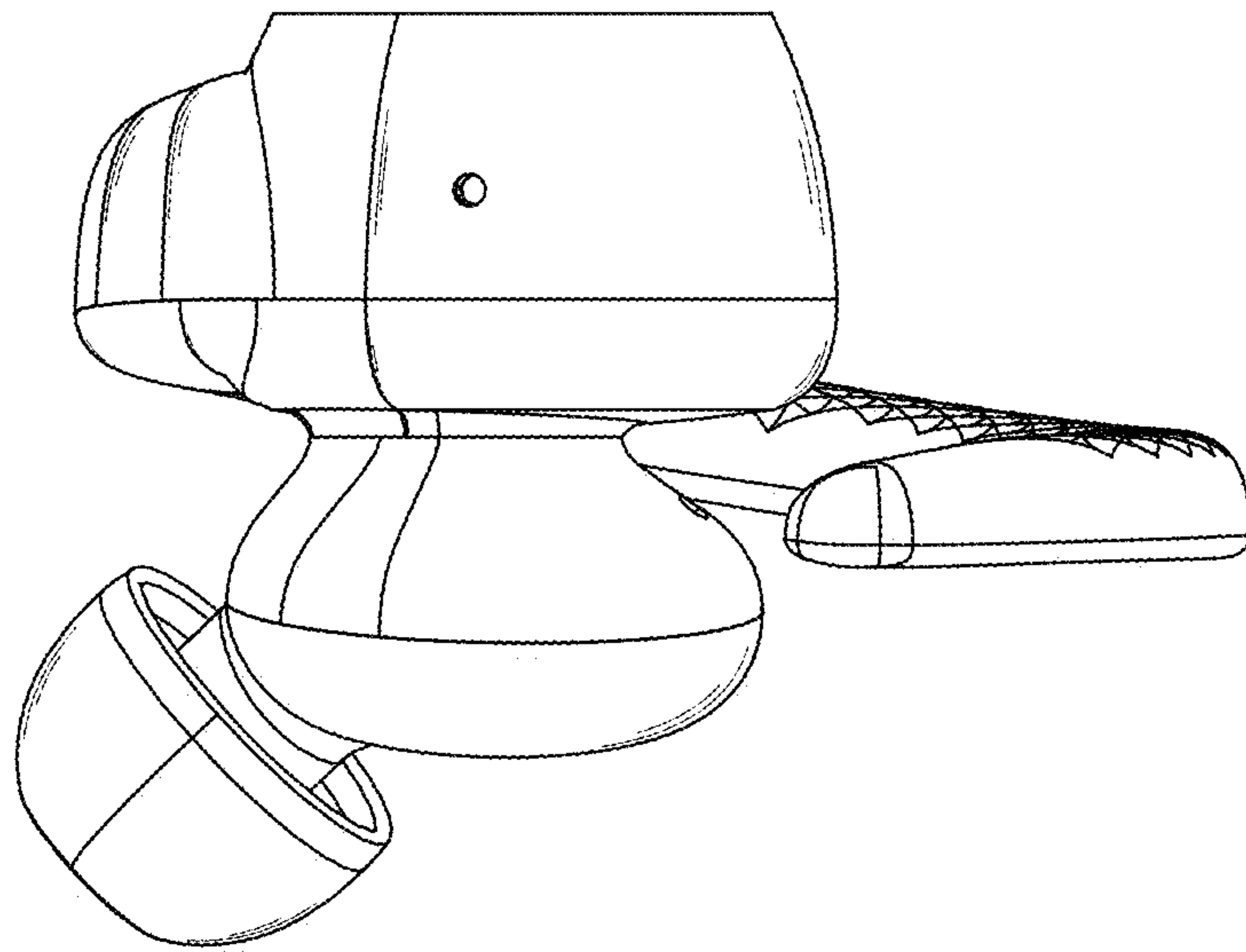


FIG.29

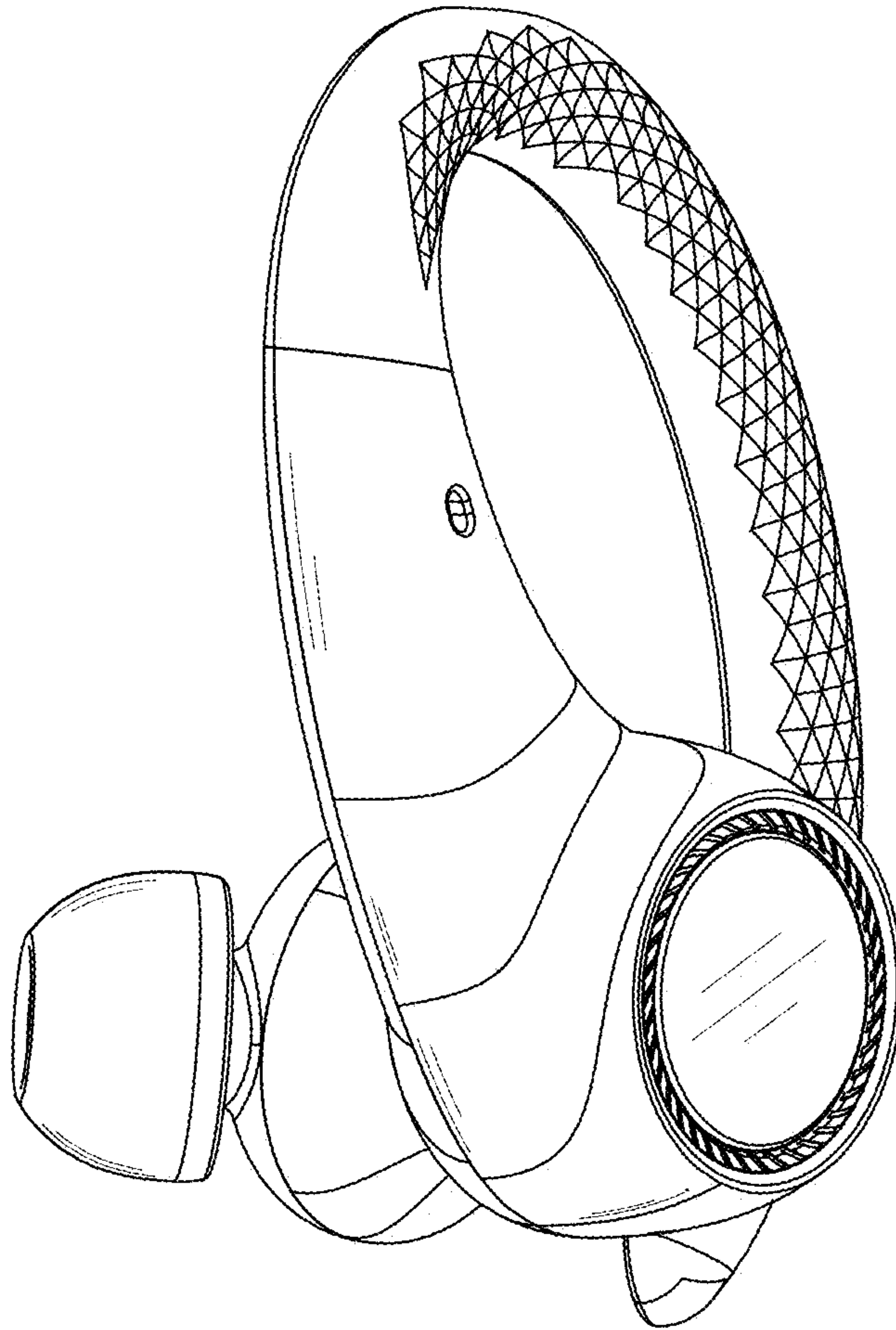


FIG.30

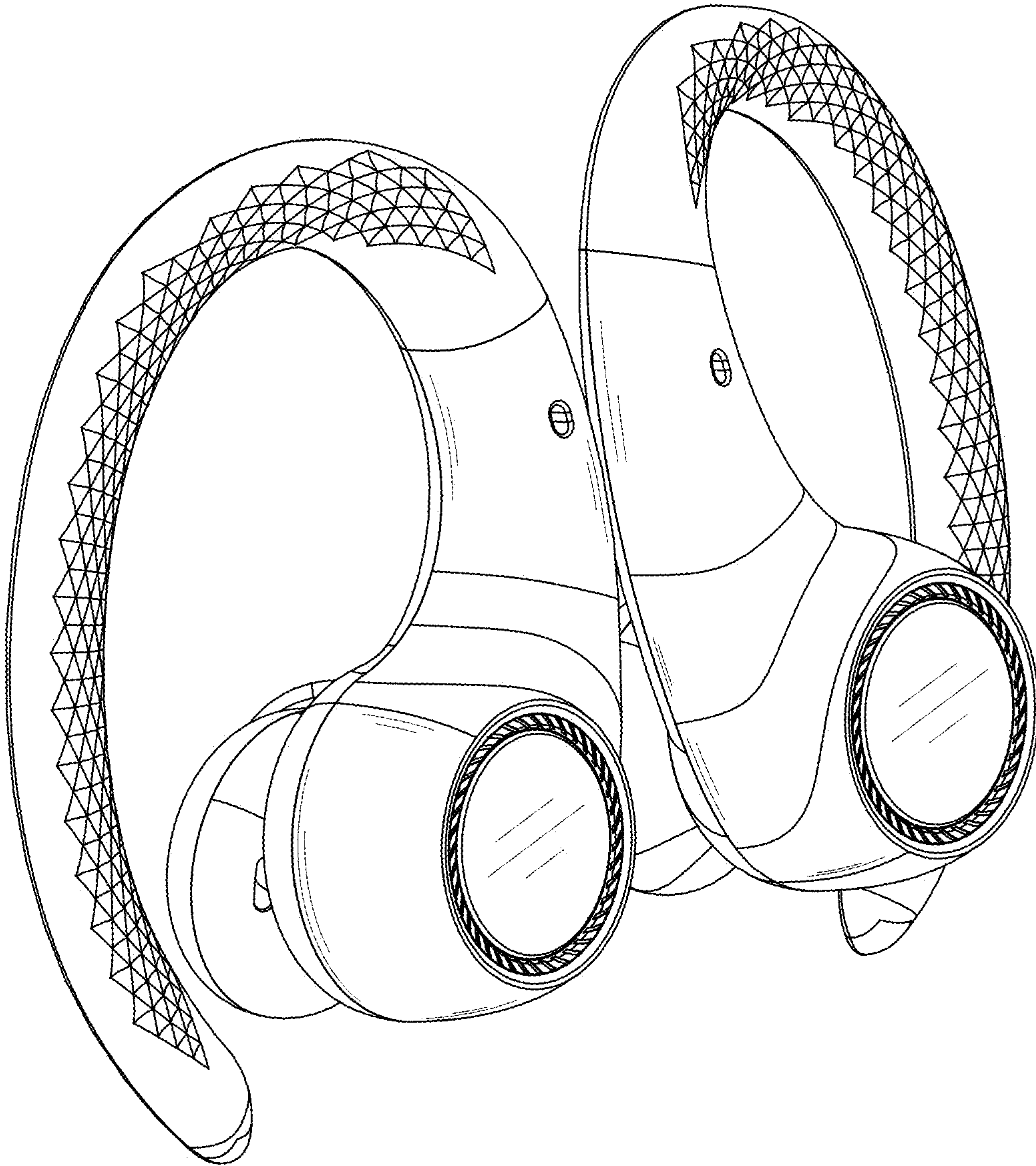


FIG.31

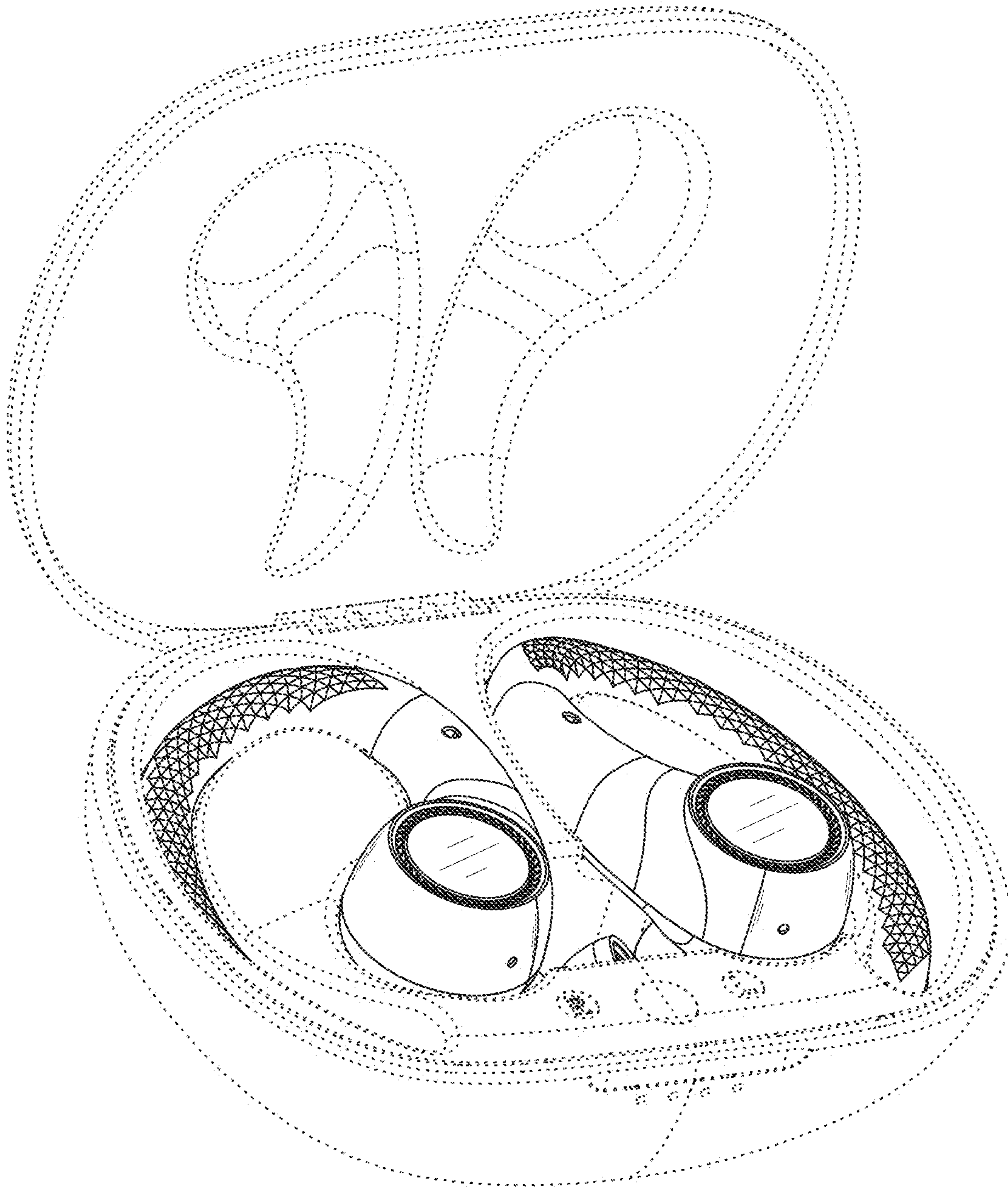


FIG.32